

**Amendments to the Drawings**

The attached sheets of drawings include changes to Figs. 1-28. These sheets, which includes Figs. 1-28, replaces the original sheets including Figs. 1-28.

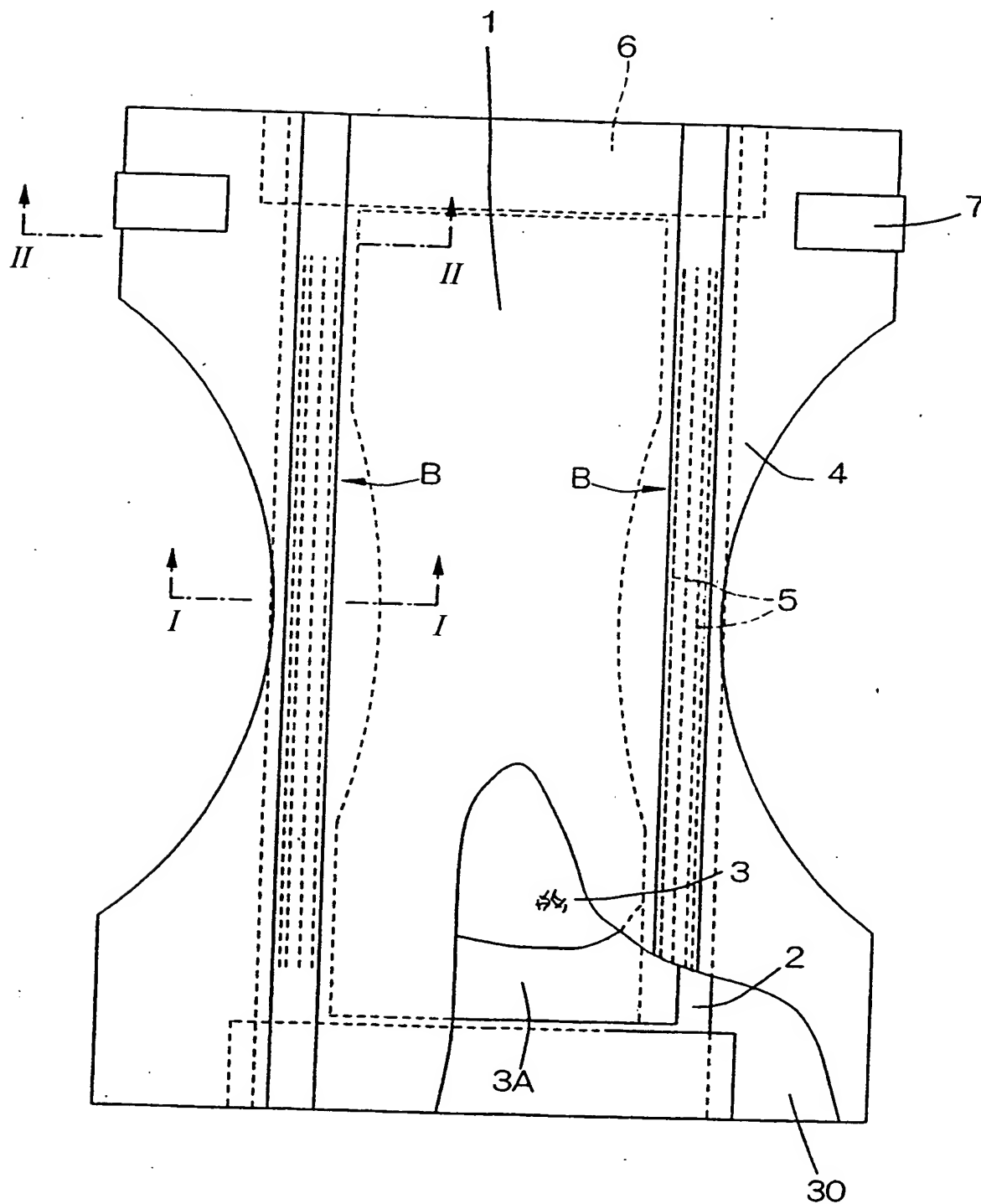
Attachment: Replacement Sheets

Annotated Sheets Showing Changes



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Fig. 1



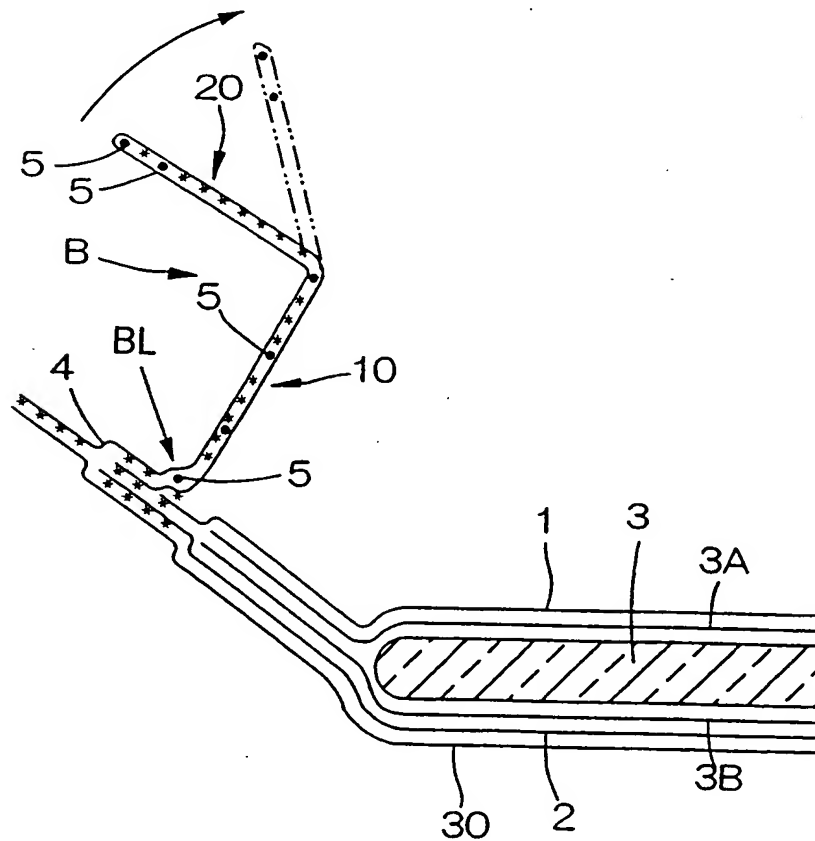
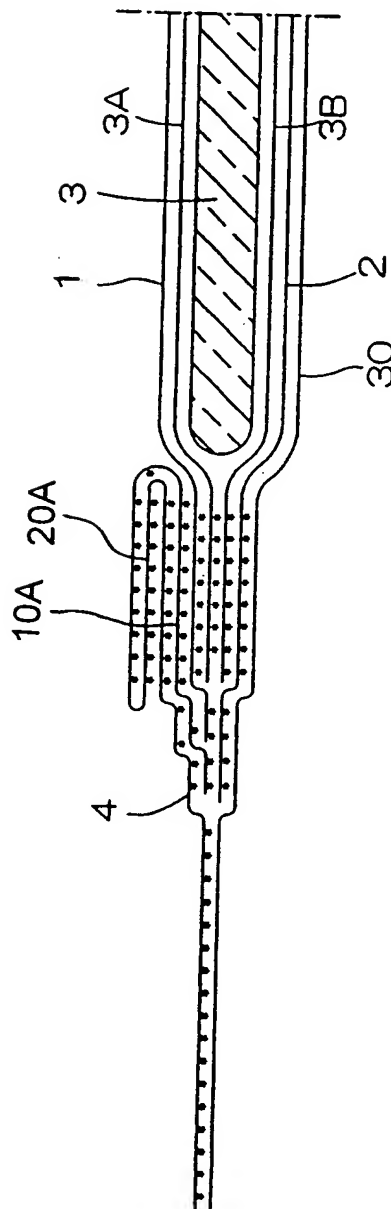




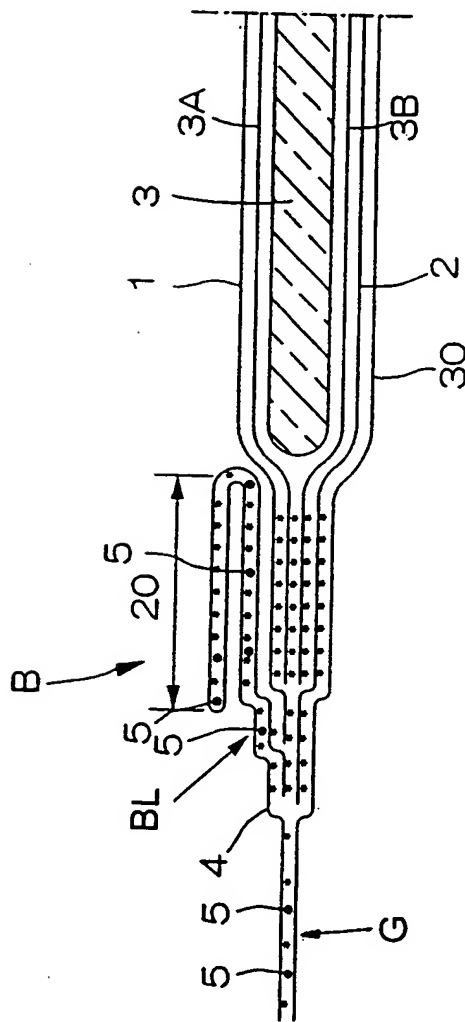
Fig. 3





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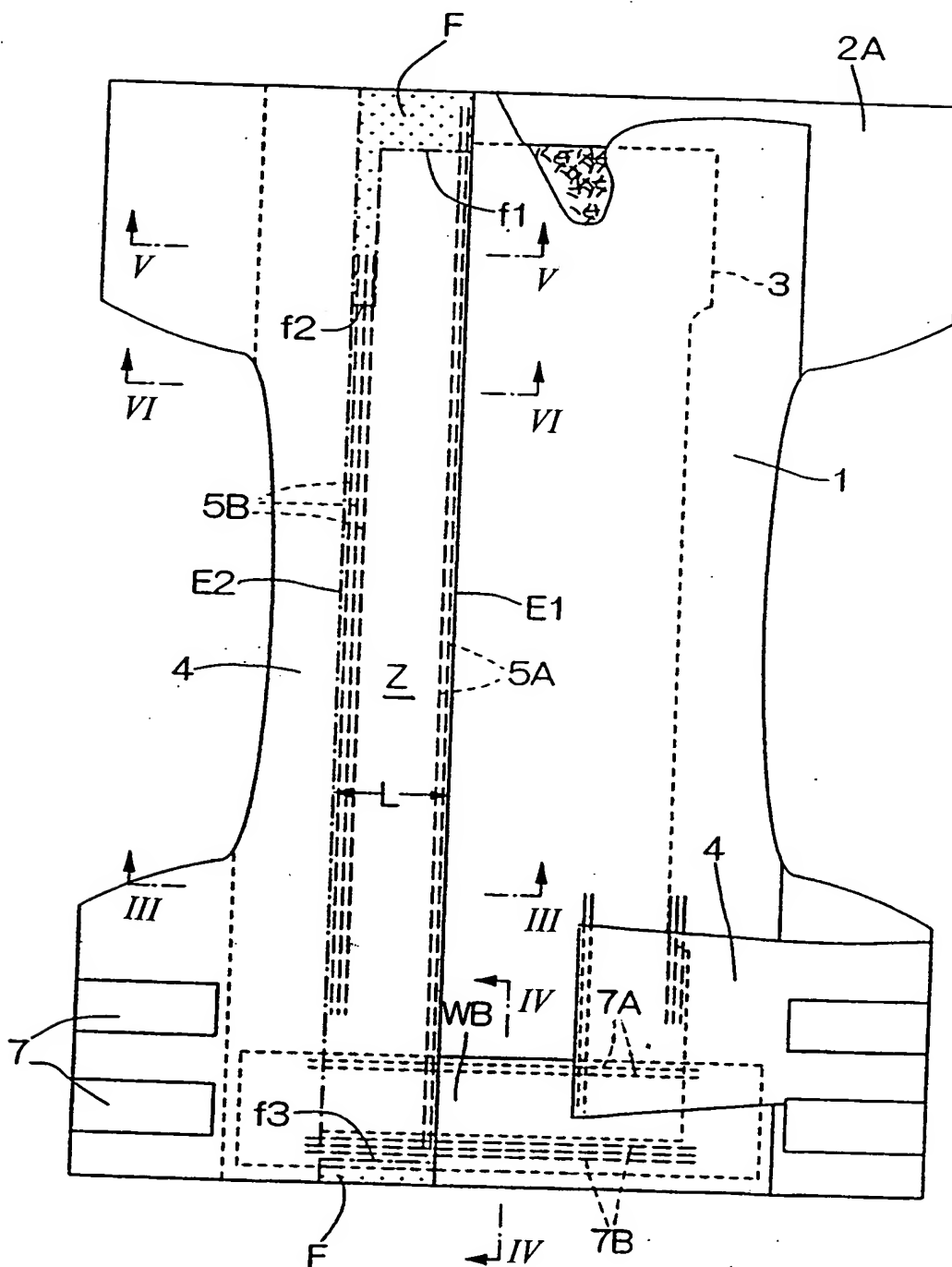
Fig. 4





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Fig. 5





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Fig. 6A

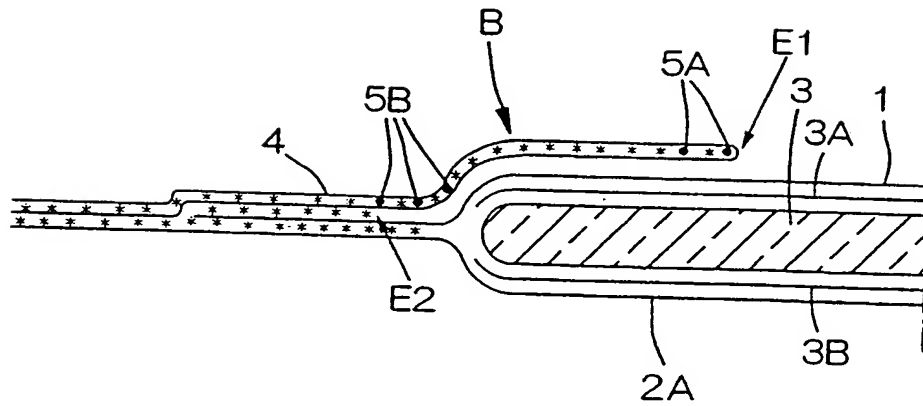
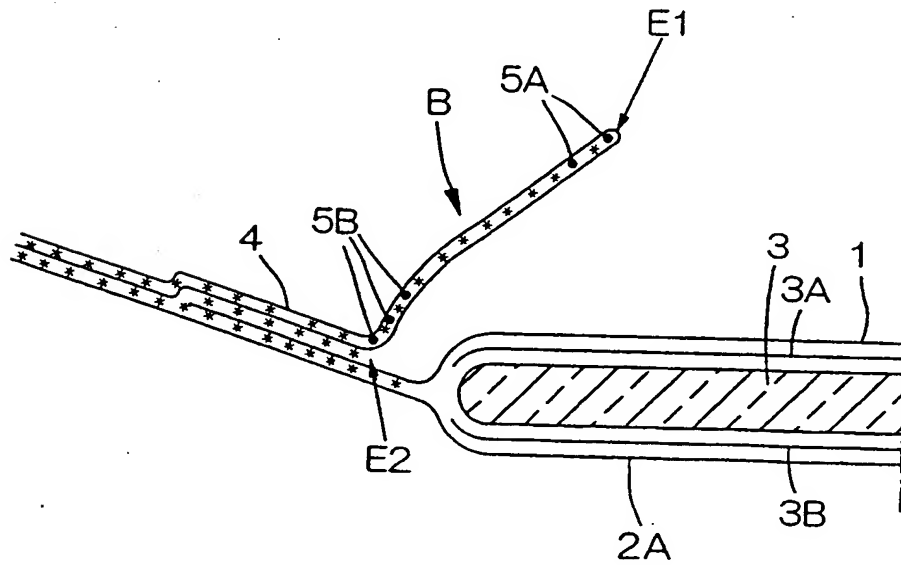


Fig. 6B

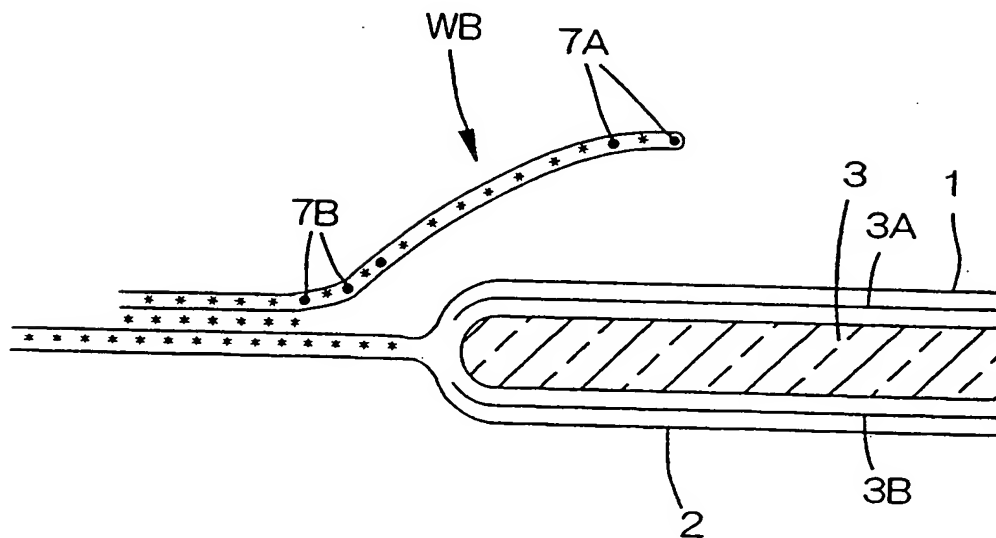




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Fig. 7







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Fig. 8A

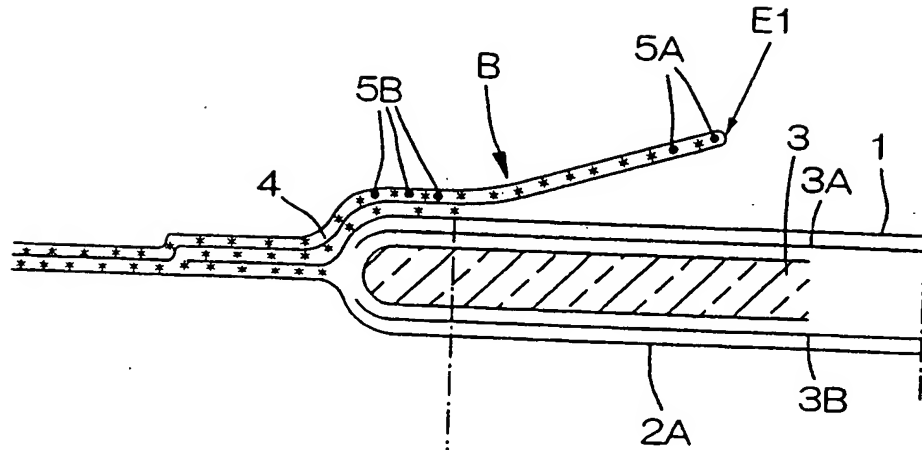
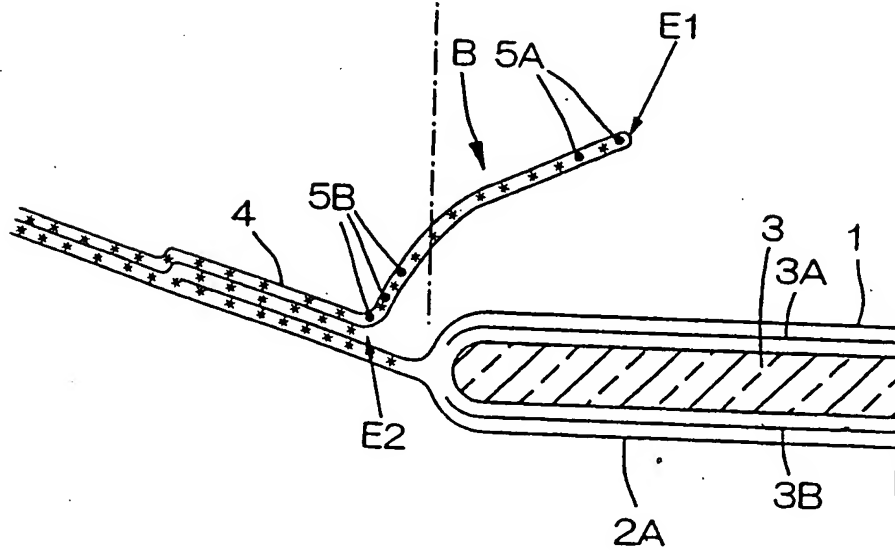


Fig. 8B





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Fig. 9A

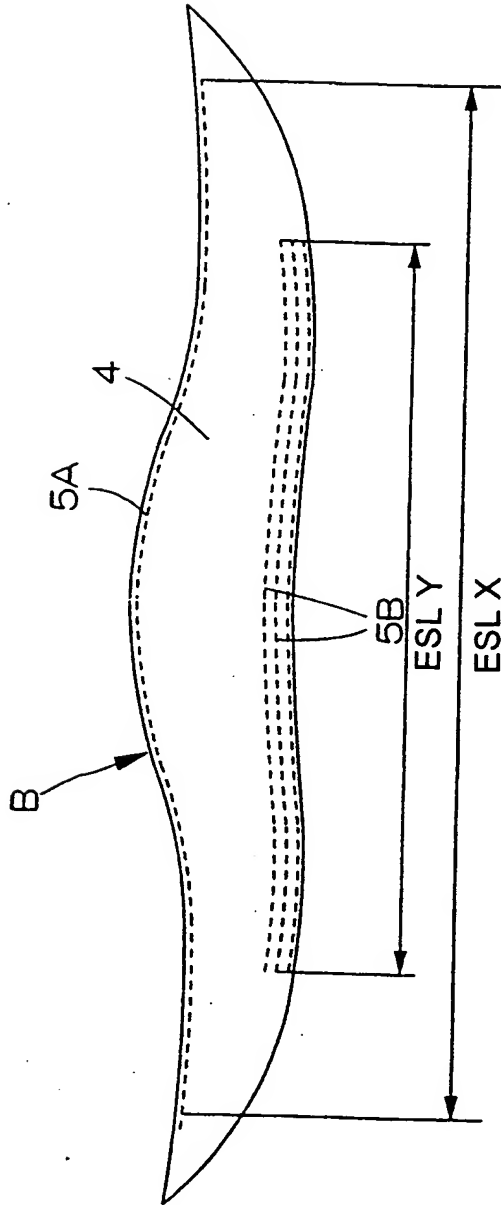
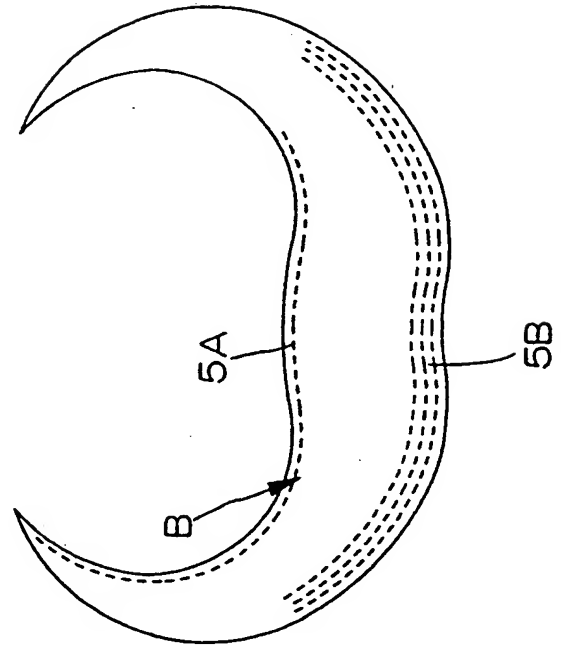


Fig. 9B

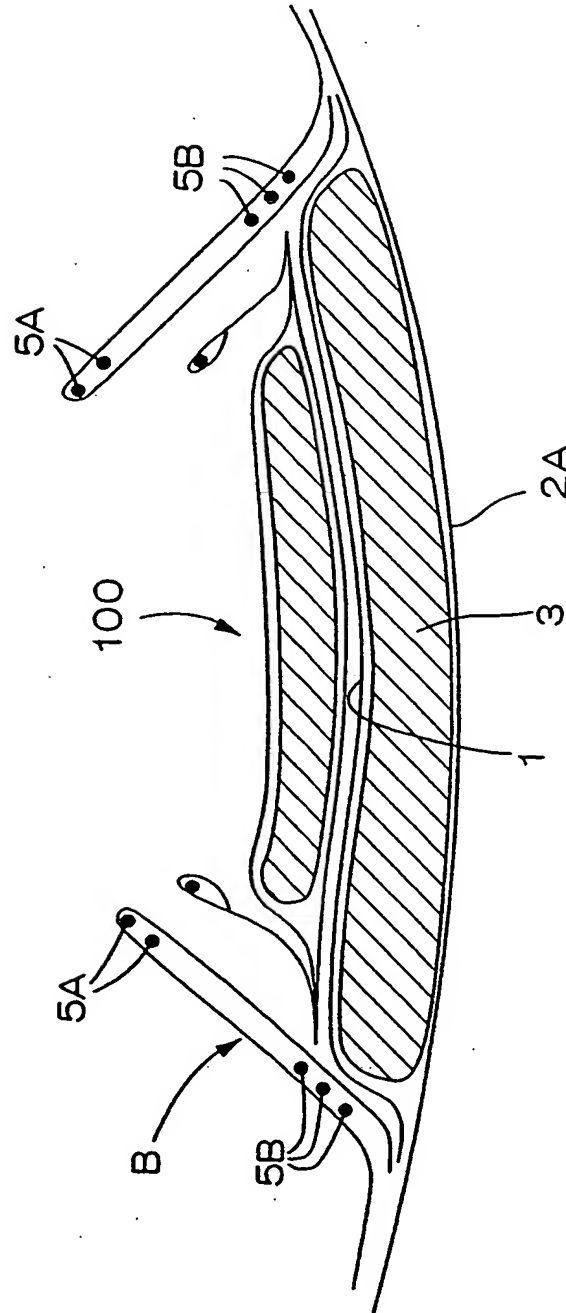




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Fig. 10

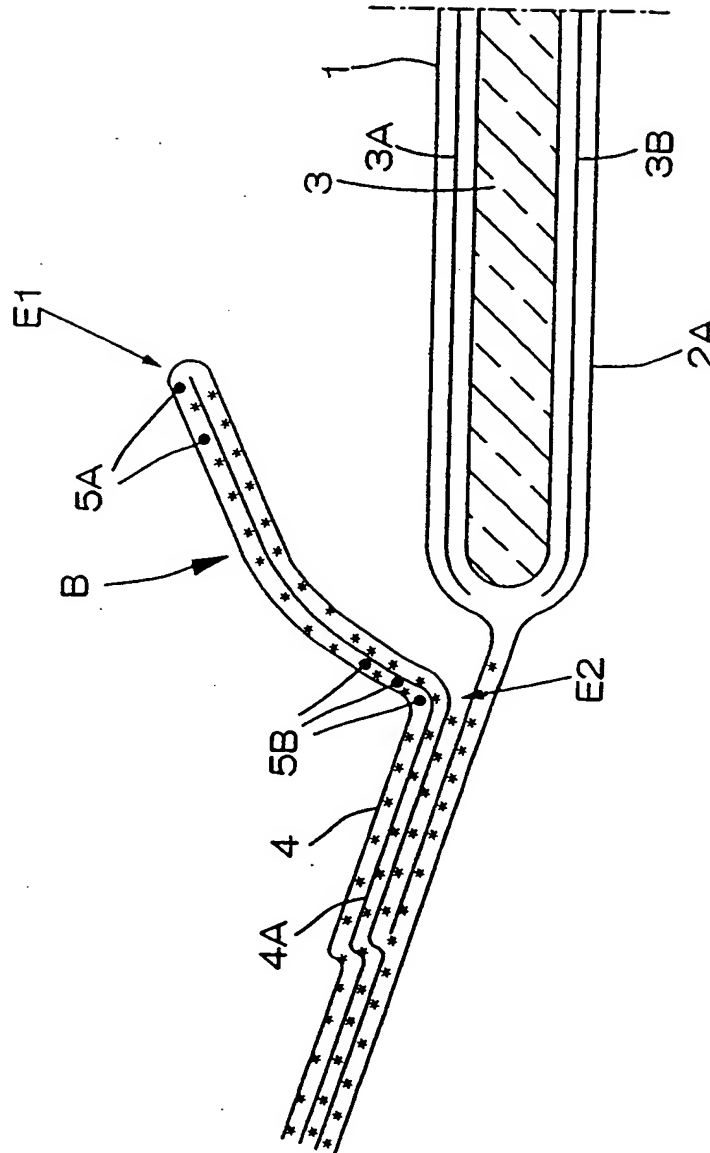




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Fig. 11



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*Fig. 12*

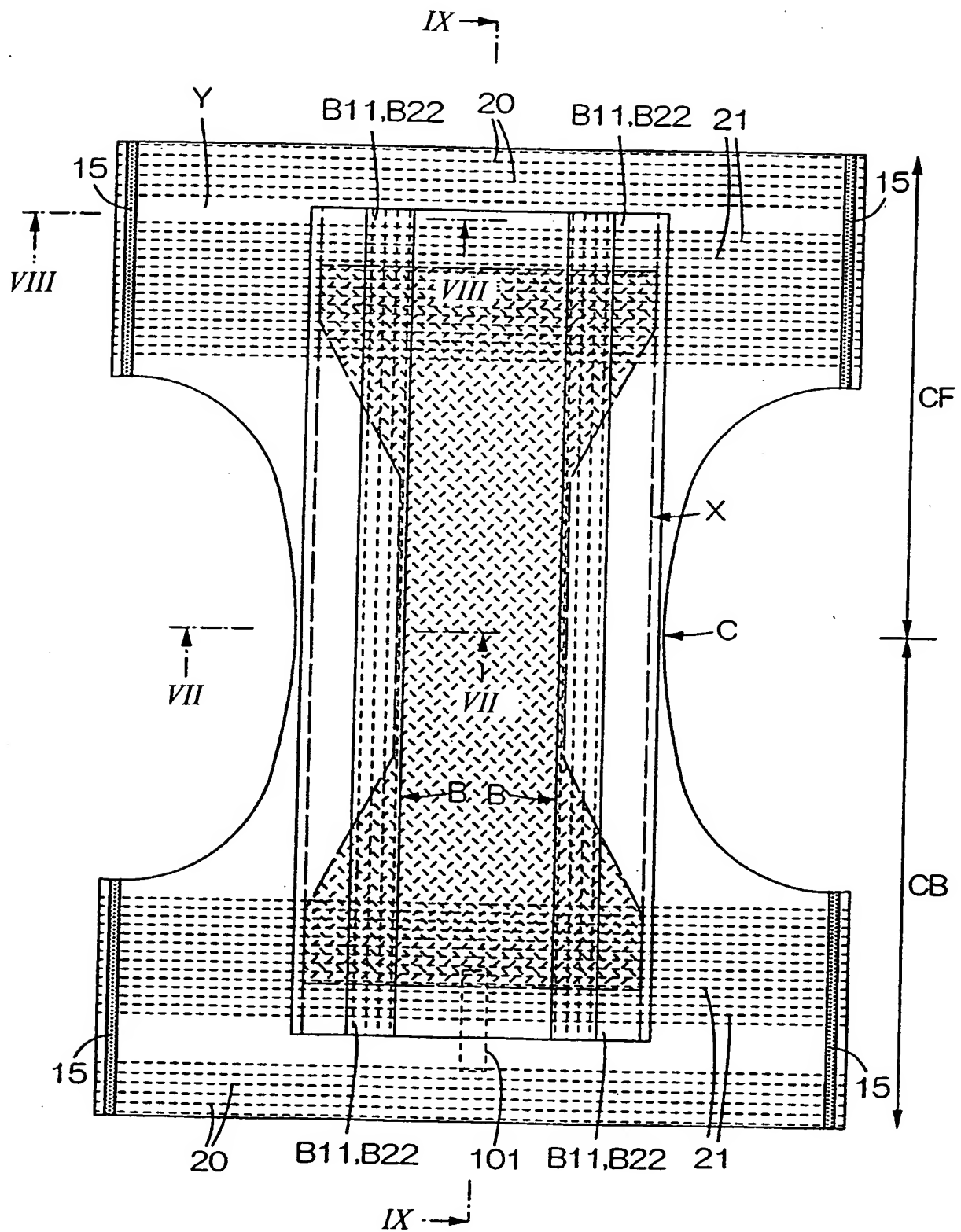




Fig. 13

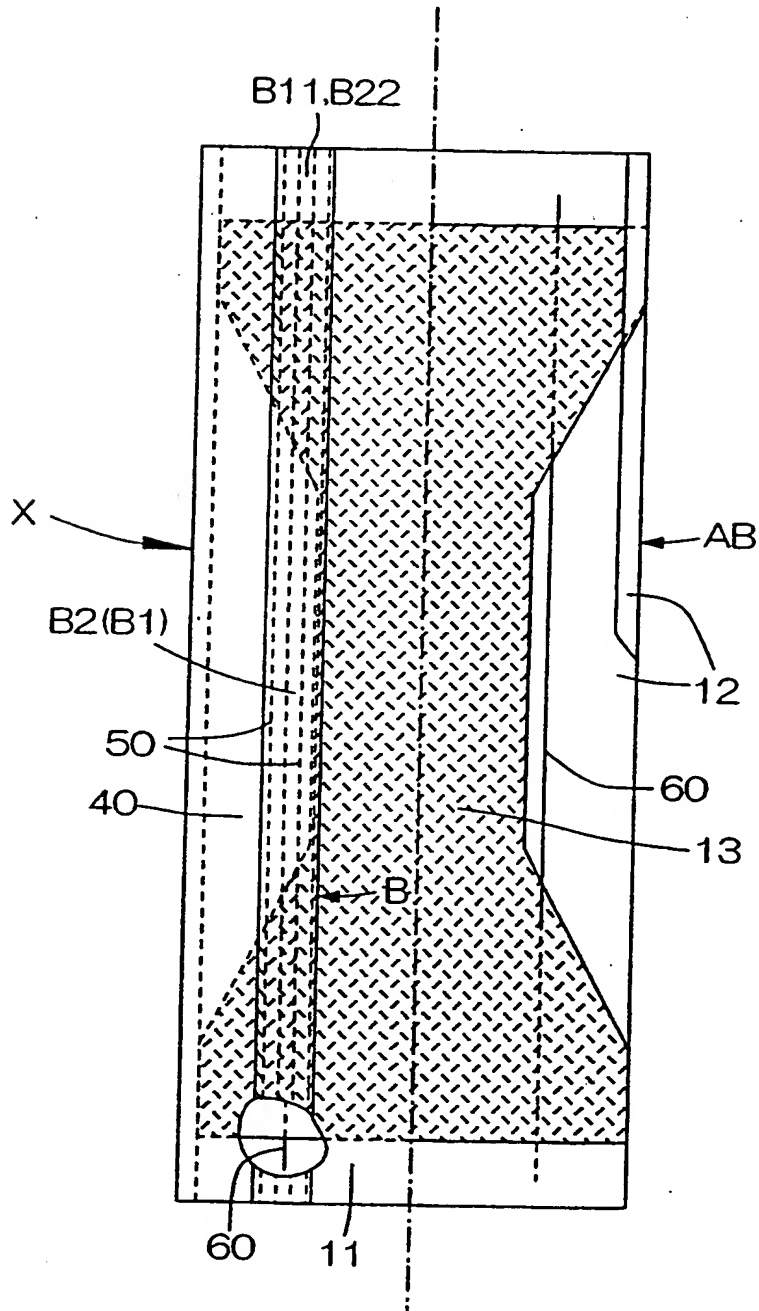
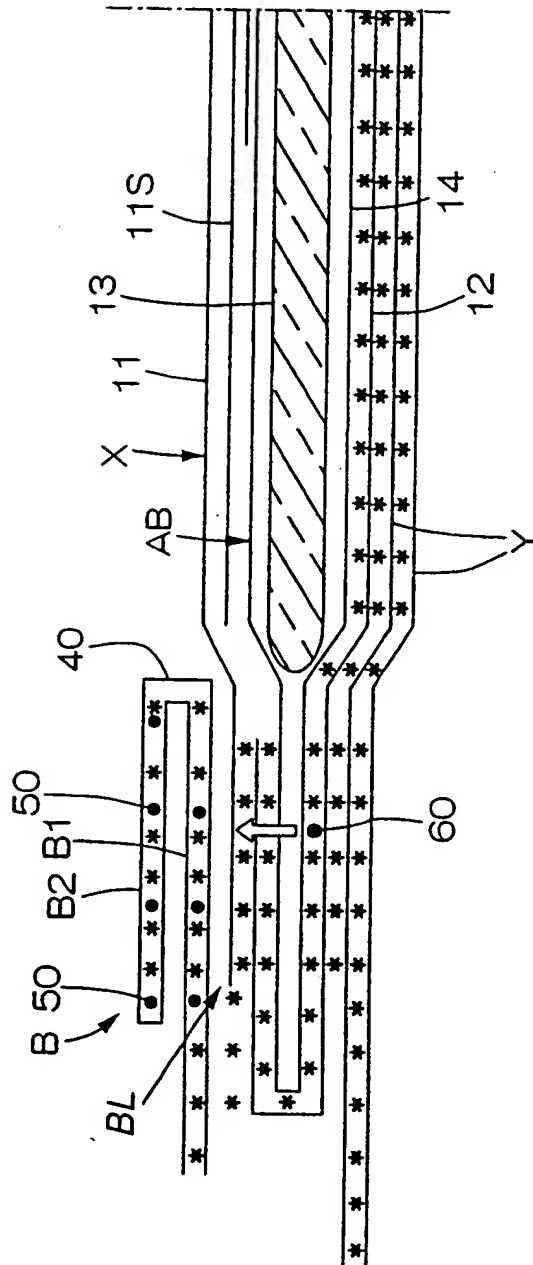




Fig. 14



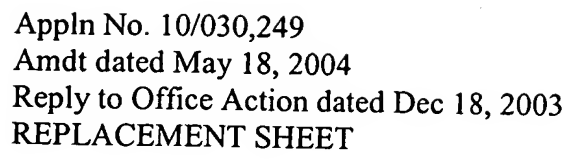
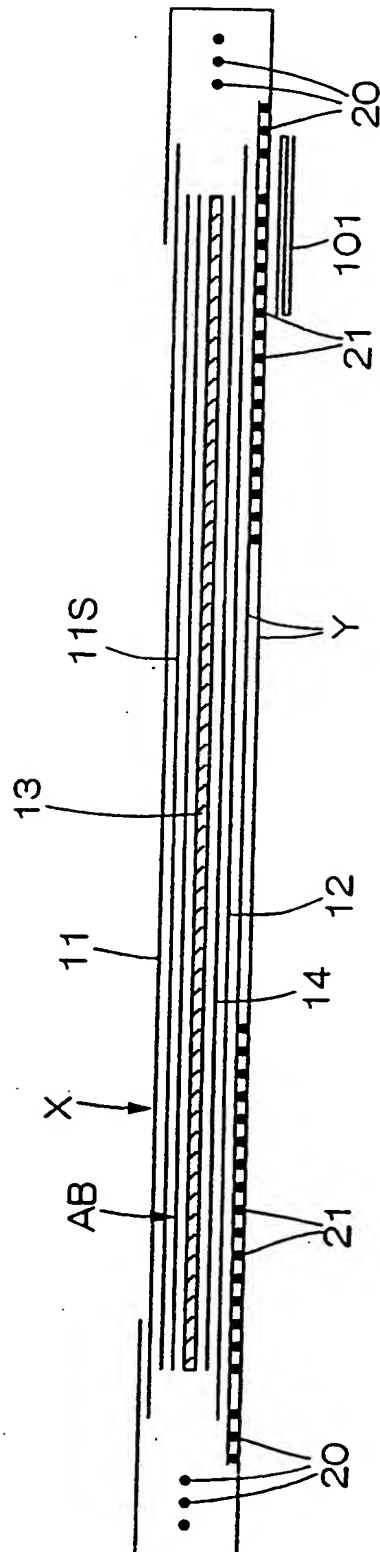
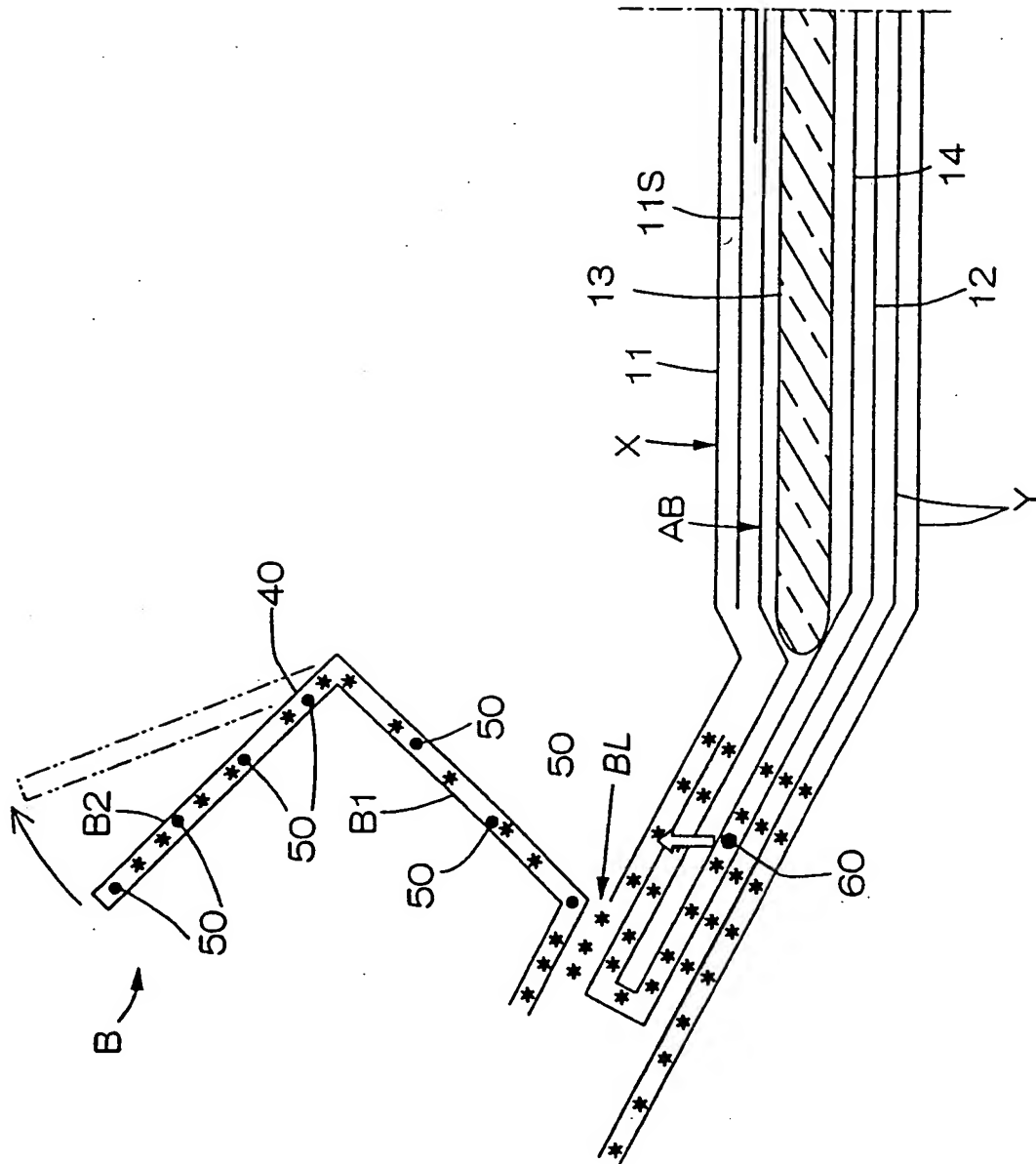


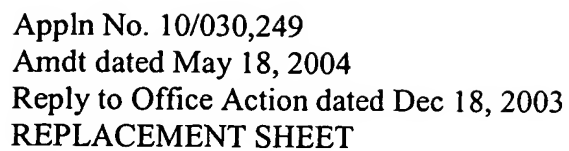




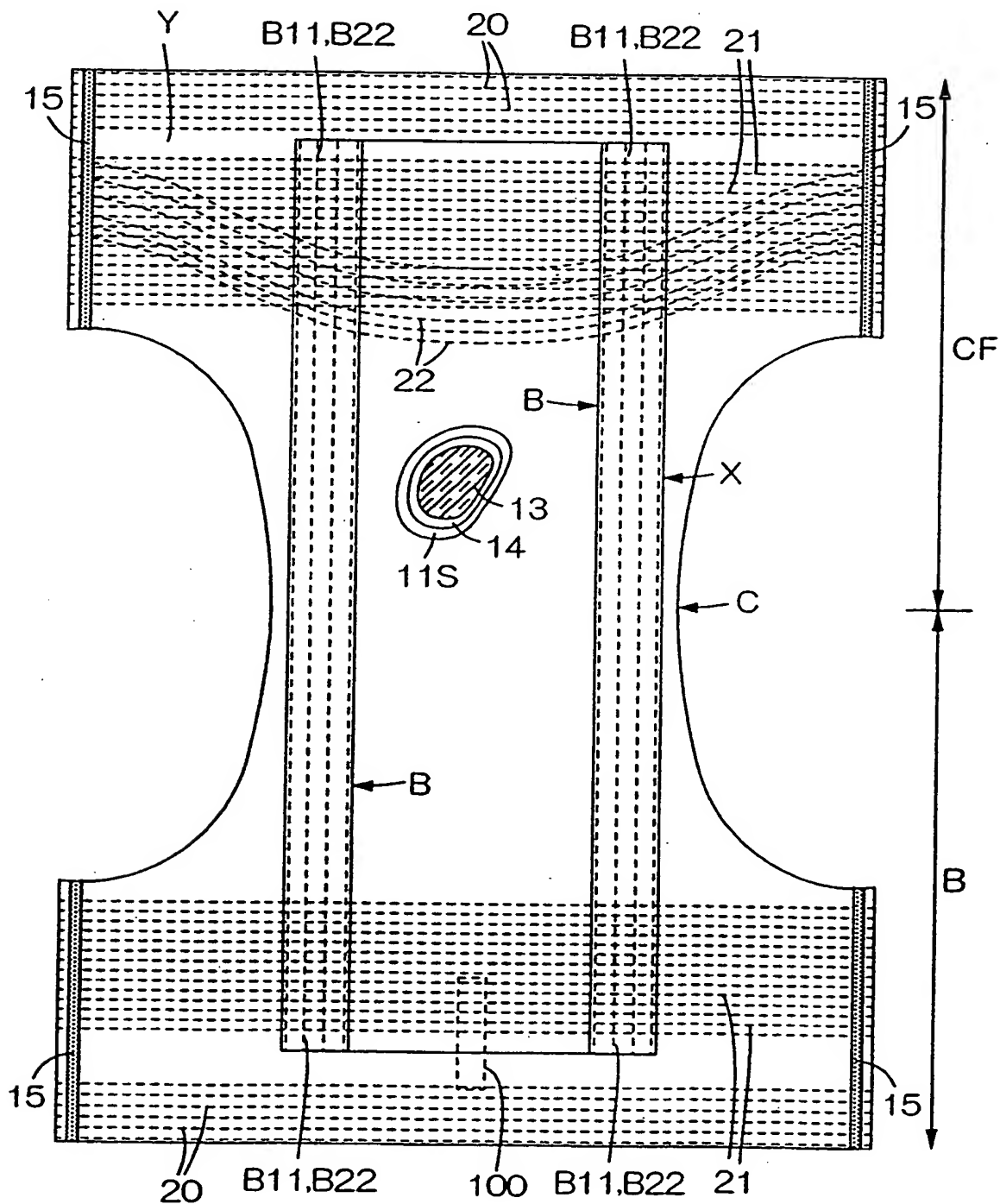
Fig. 16

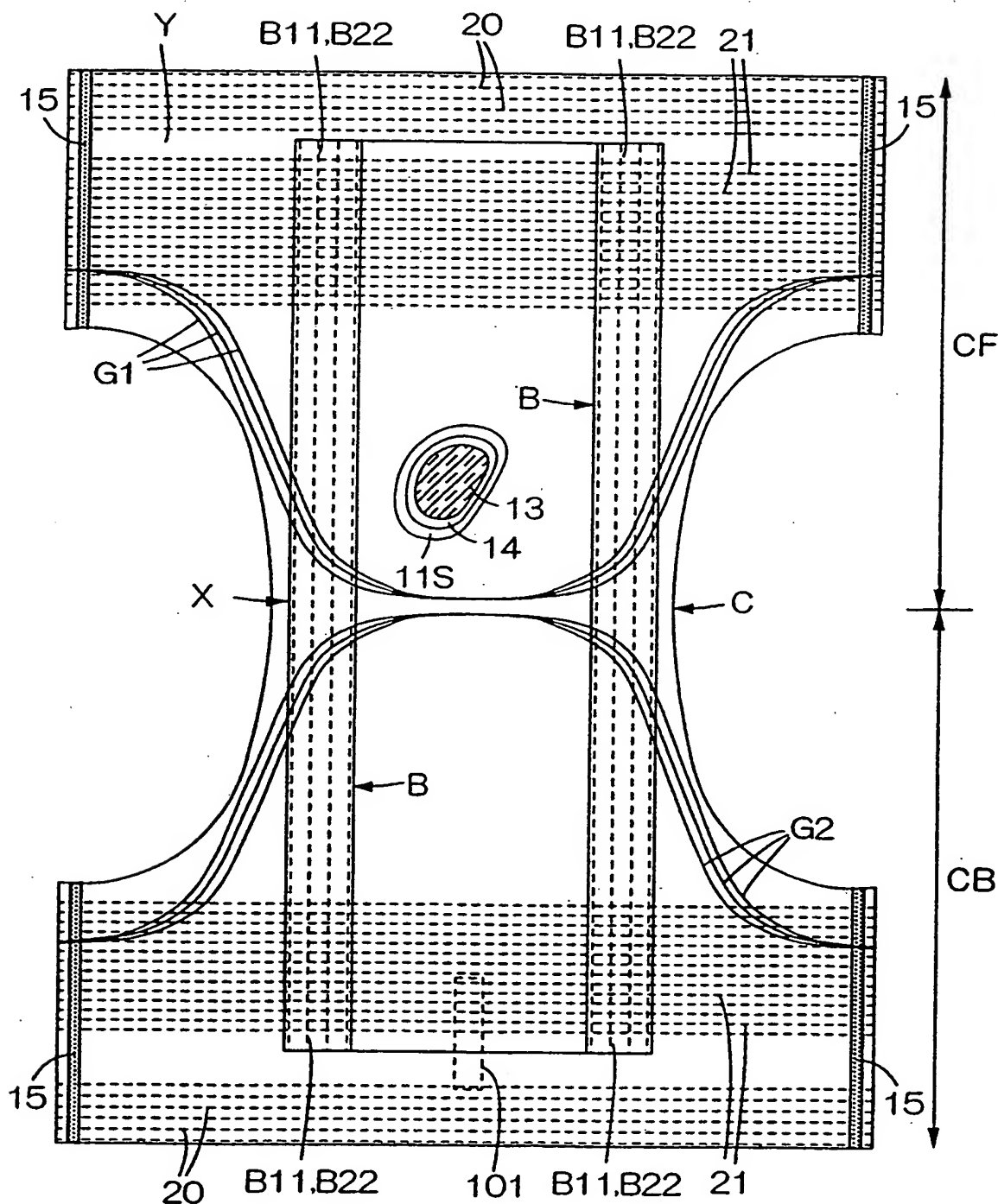


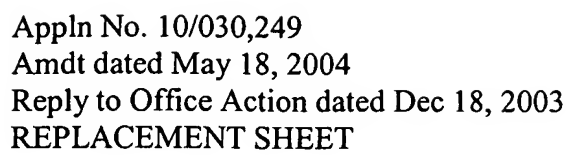




**Fig. 18**







**Fig. 20**

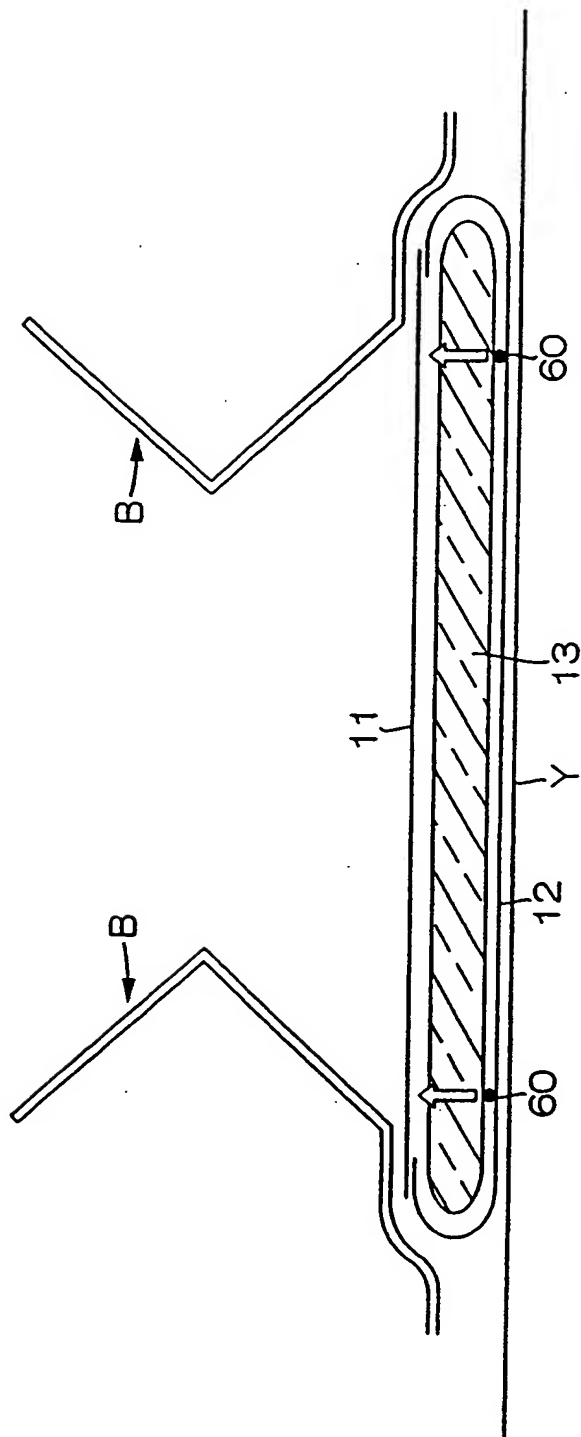




Fig. 21

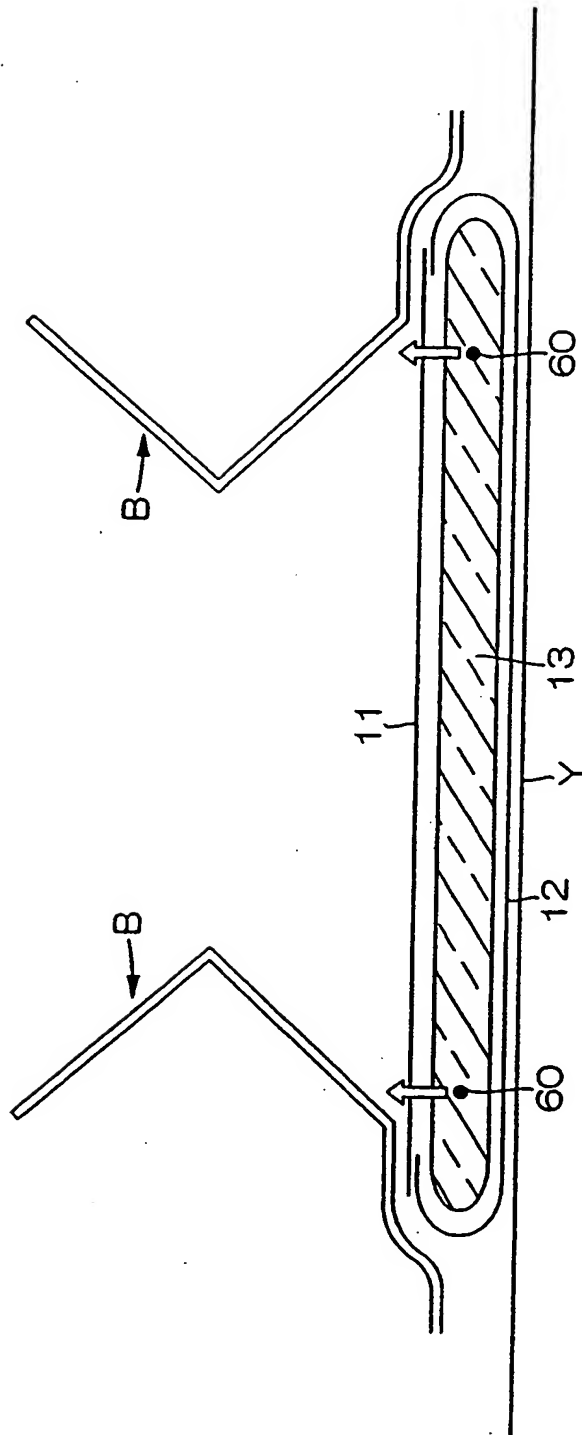
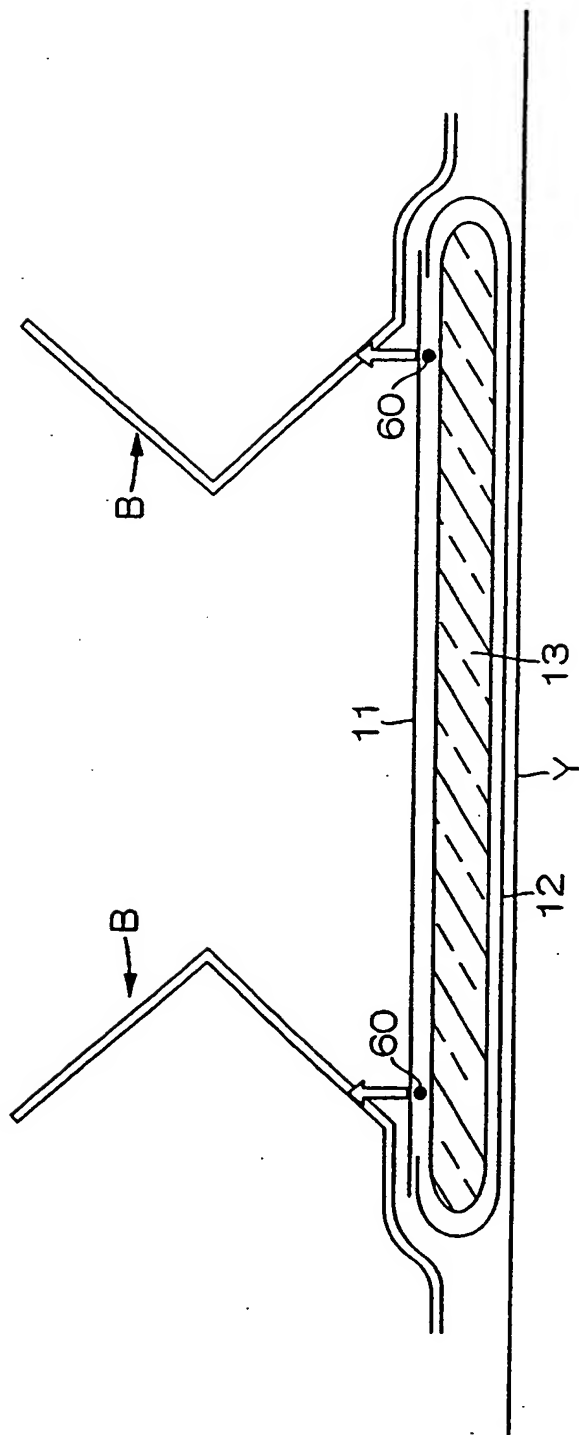


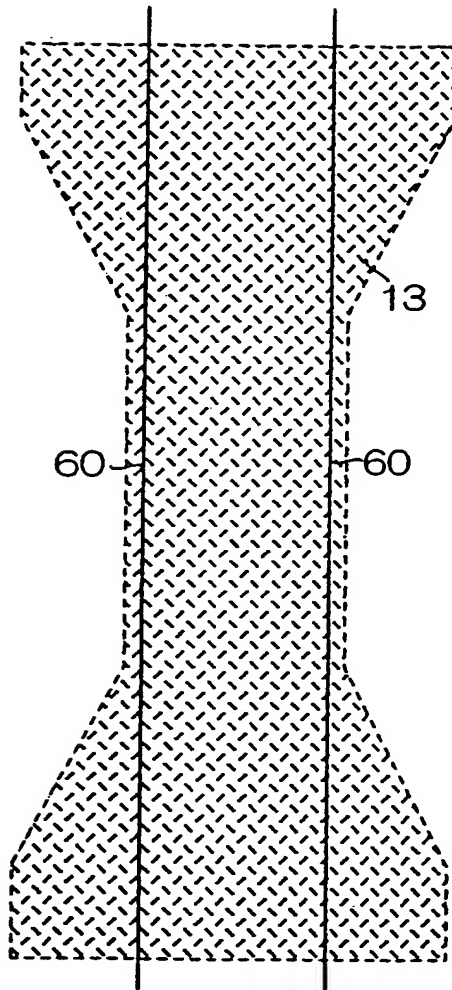


Fig. 22



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*Fig. 23*





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*Fig. 24*

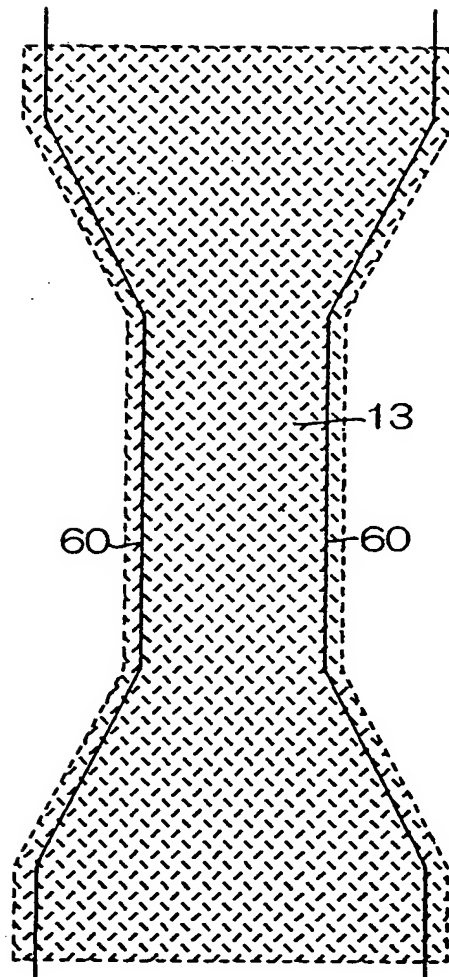




Fig. 25

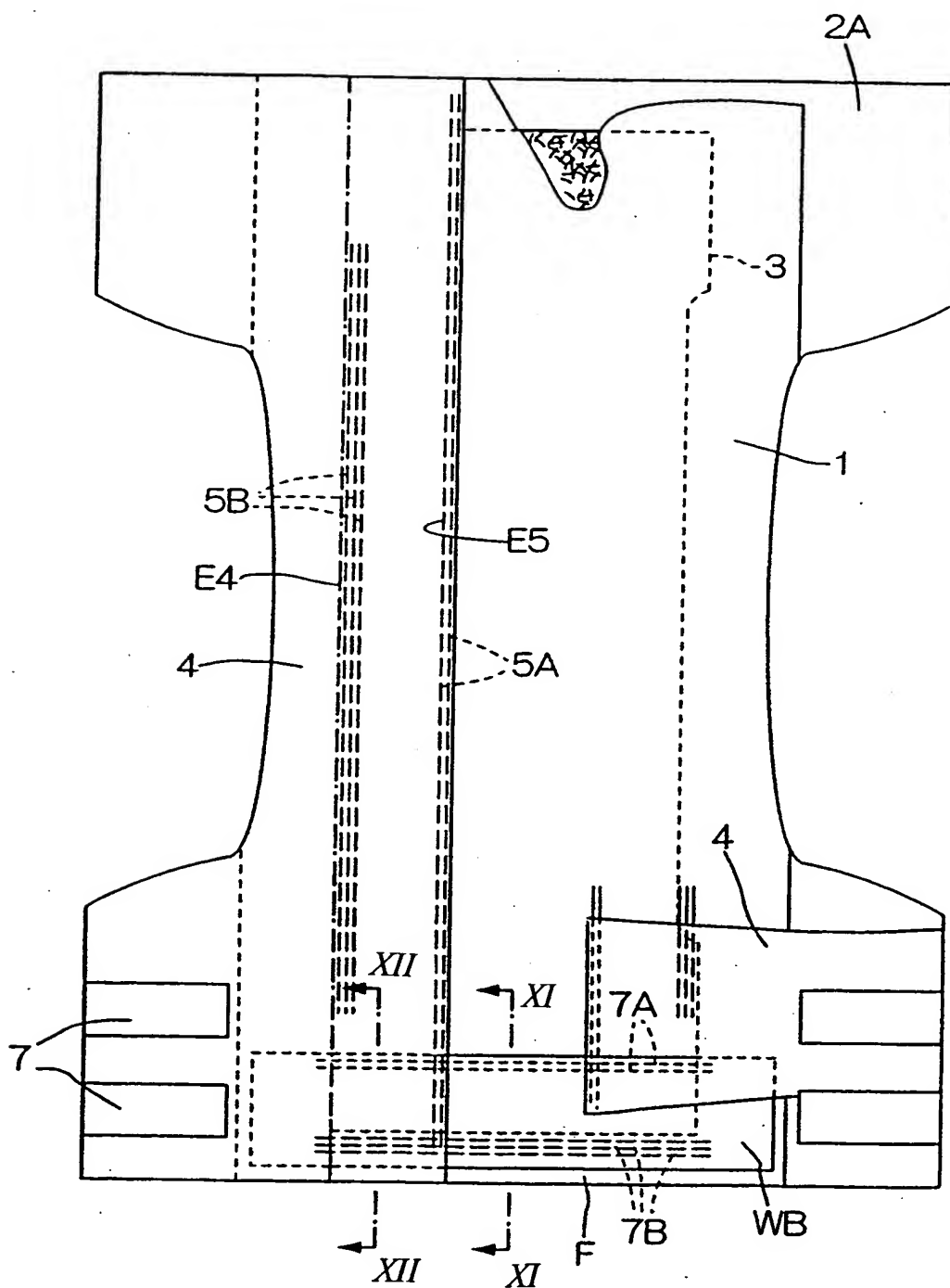




Fig. 26A

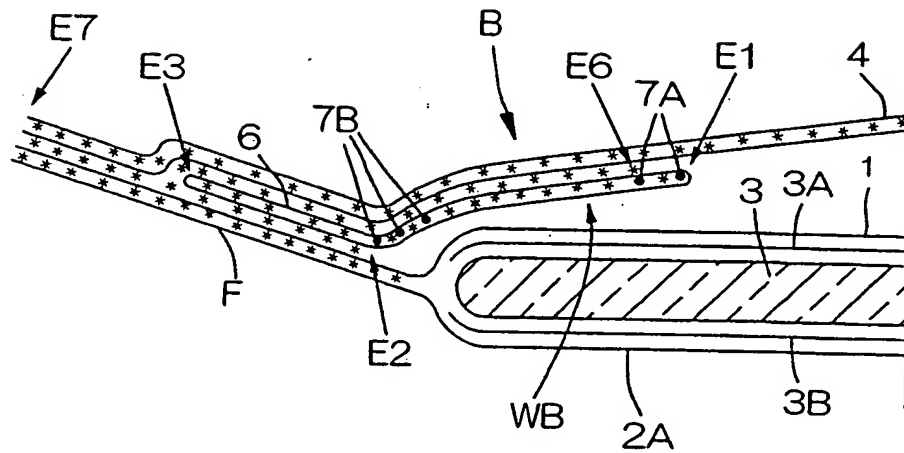


Fig. 26B

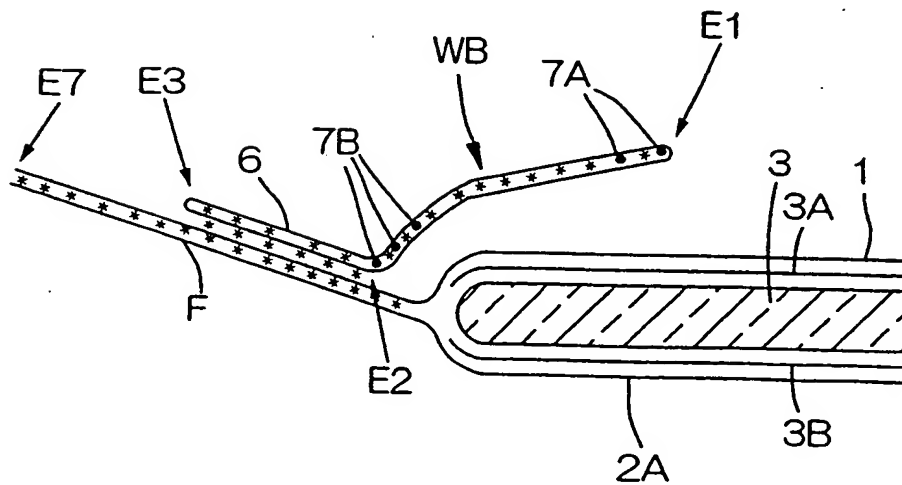
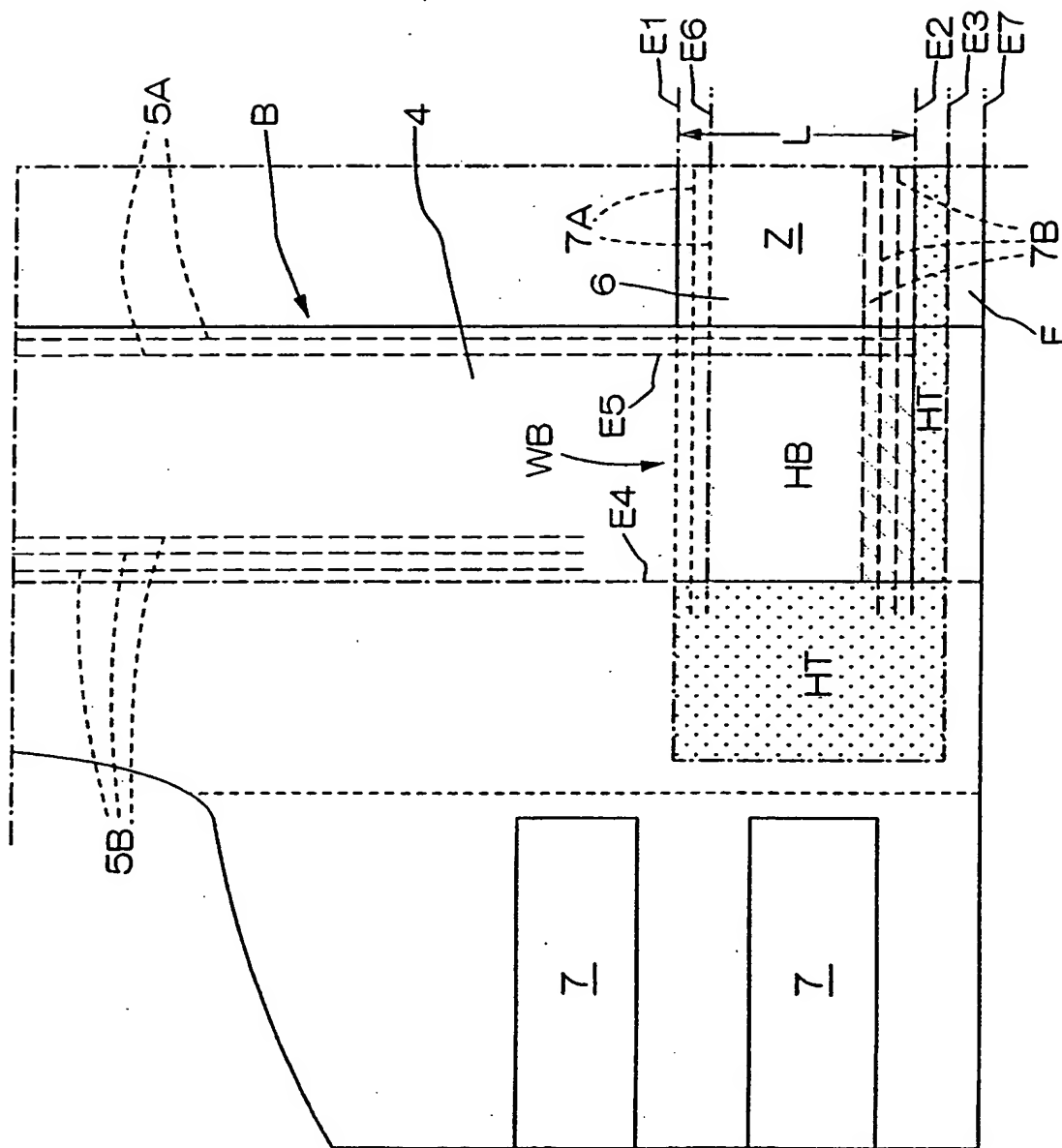
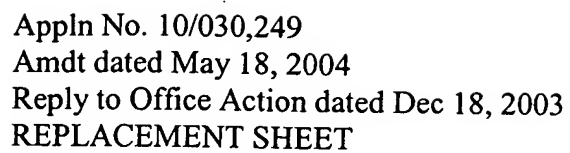




Fig. 27





~~第1図~~ Fig. 1

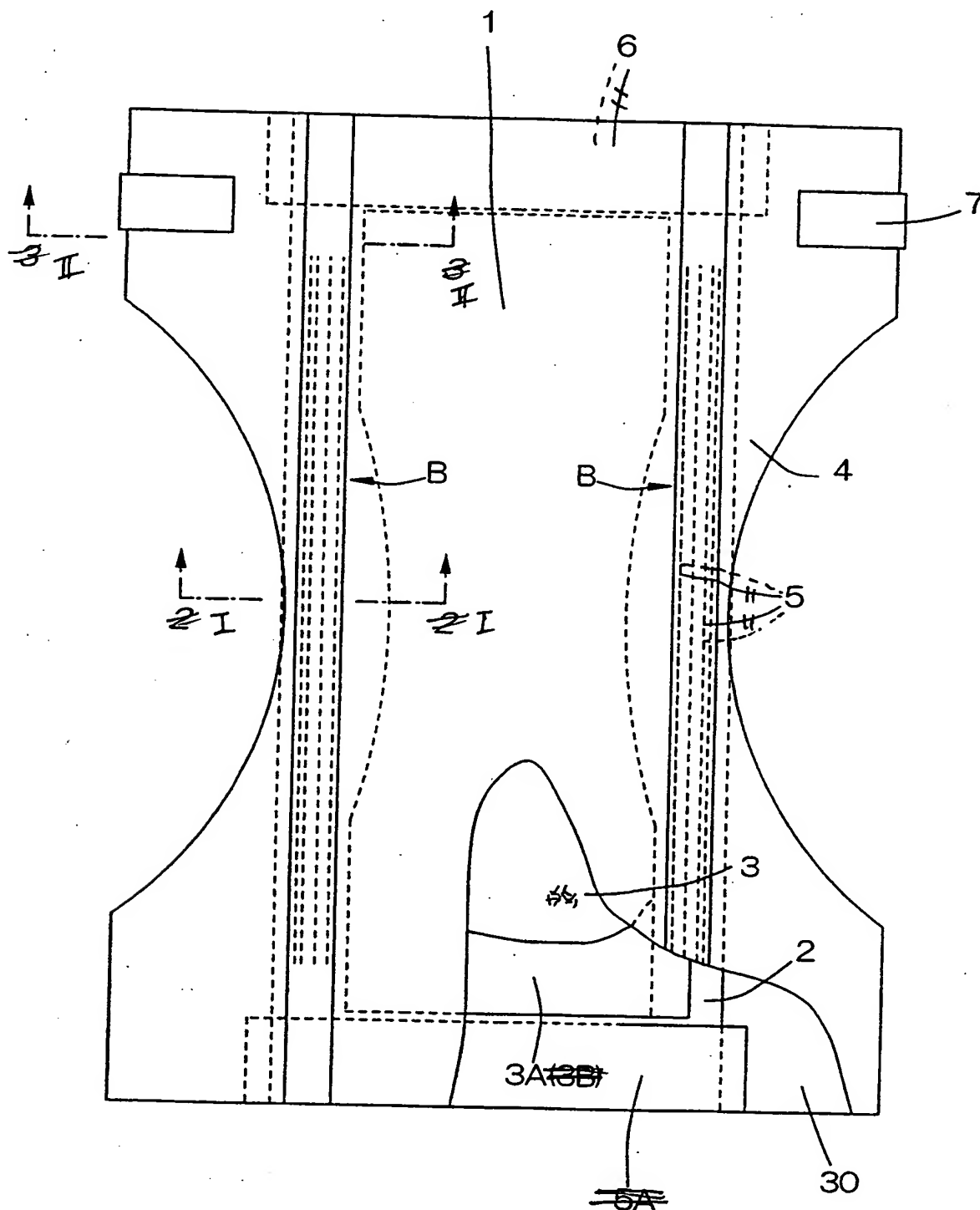


Fig. 2A

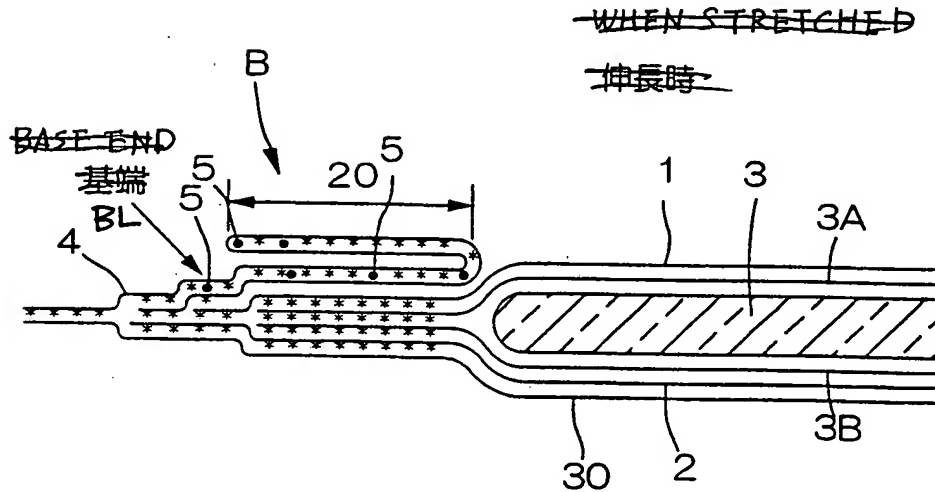
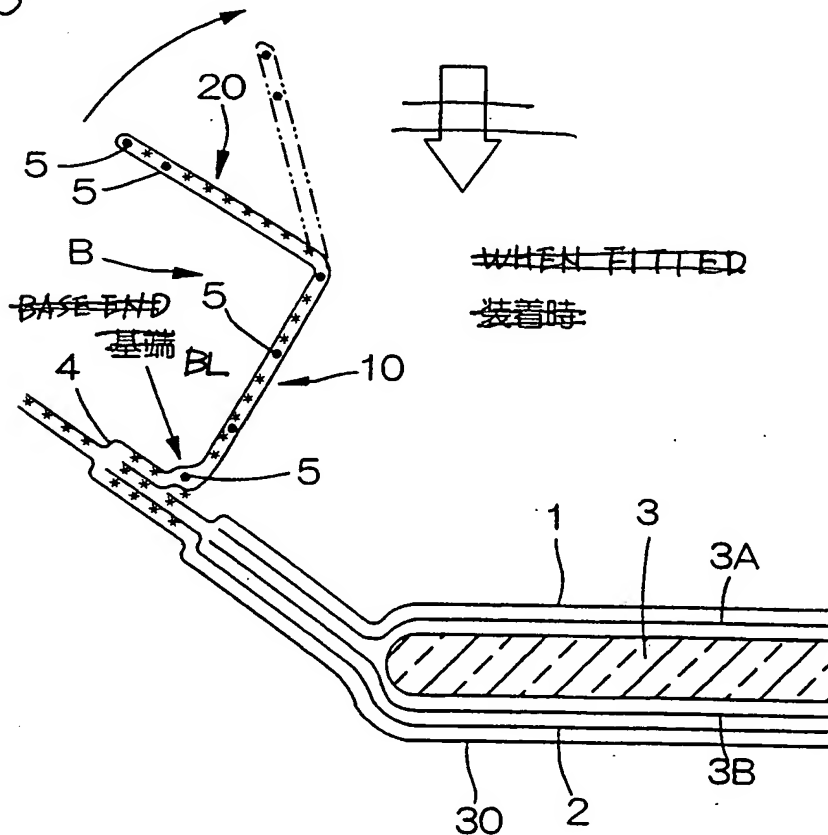


Fig. 2B



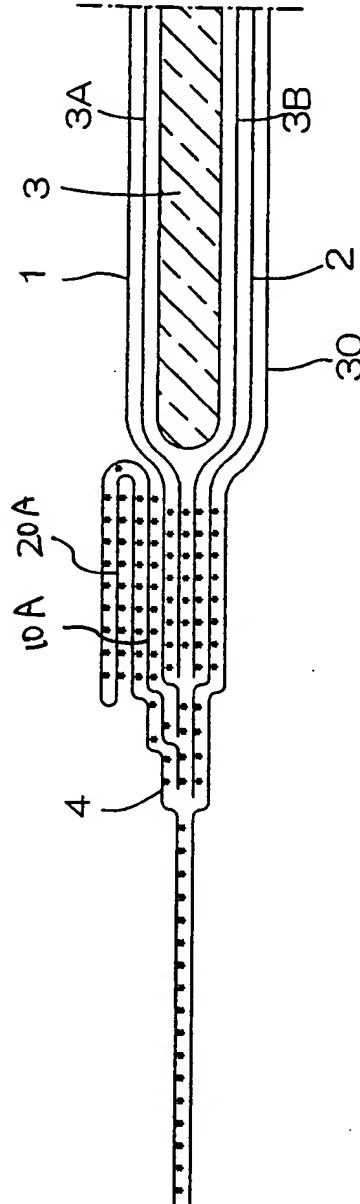
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第3図 Fig. 3

~~WHEN STRETCHED~~

伸長時

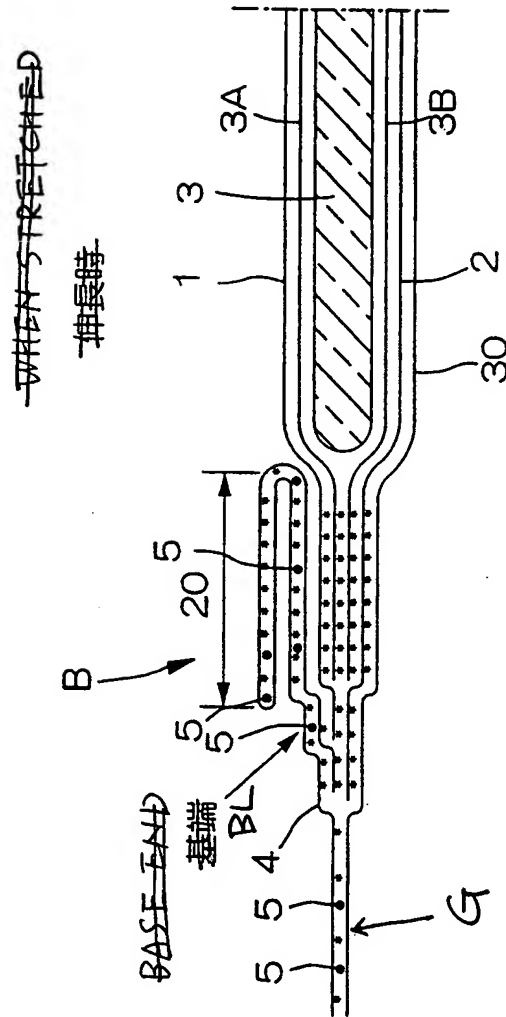




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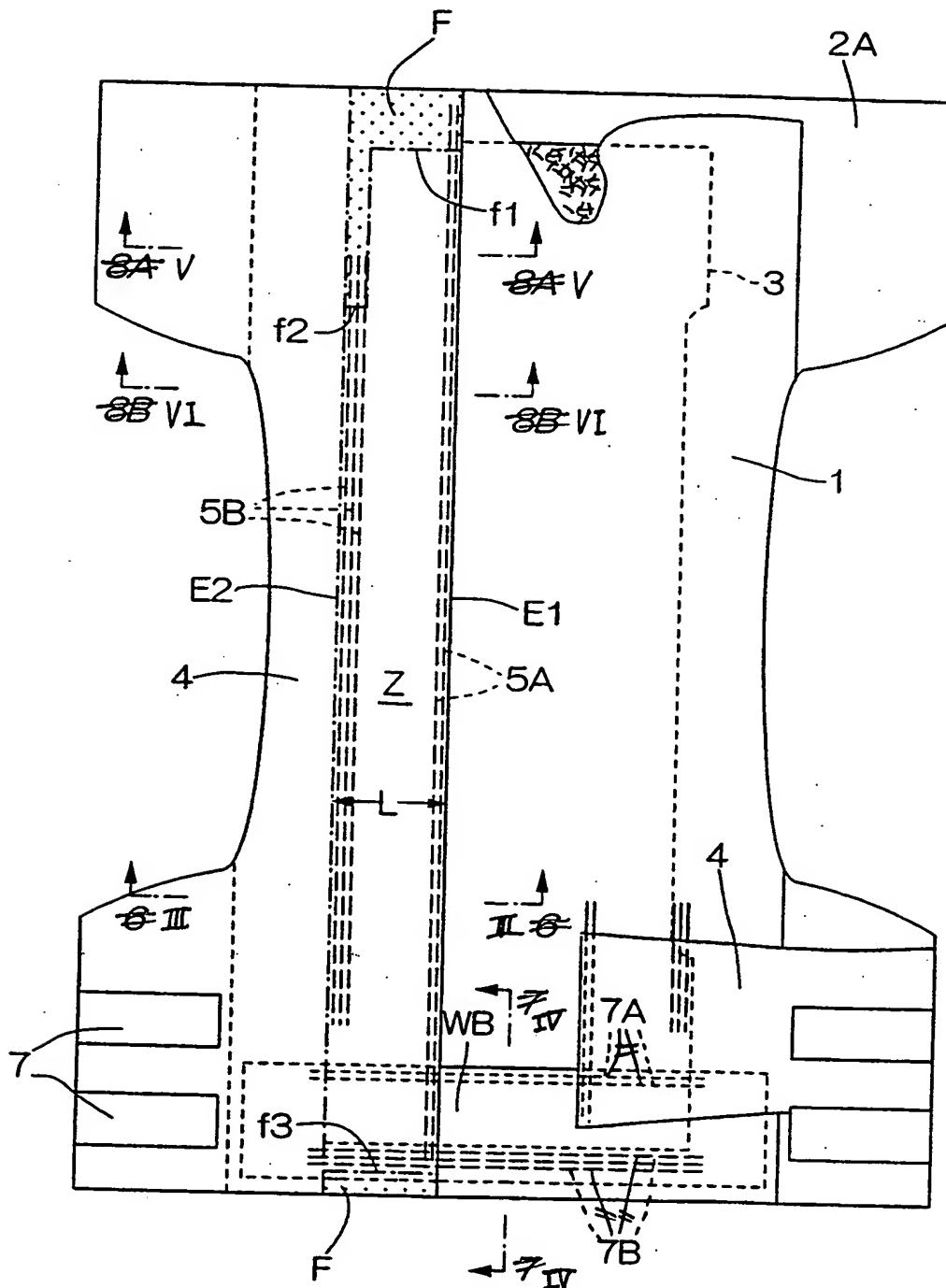
Fig. 4





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~~第5图~~ Fig. 5





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~~第6圖~~

Fig. 6A

~~伸長時 WHEN STRETCHED~~

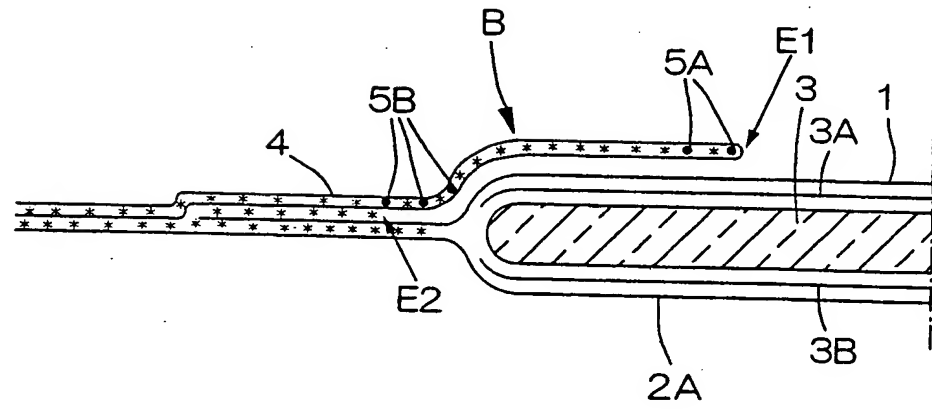
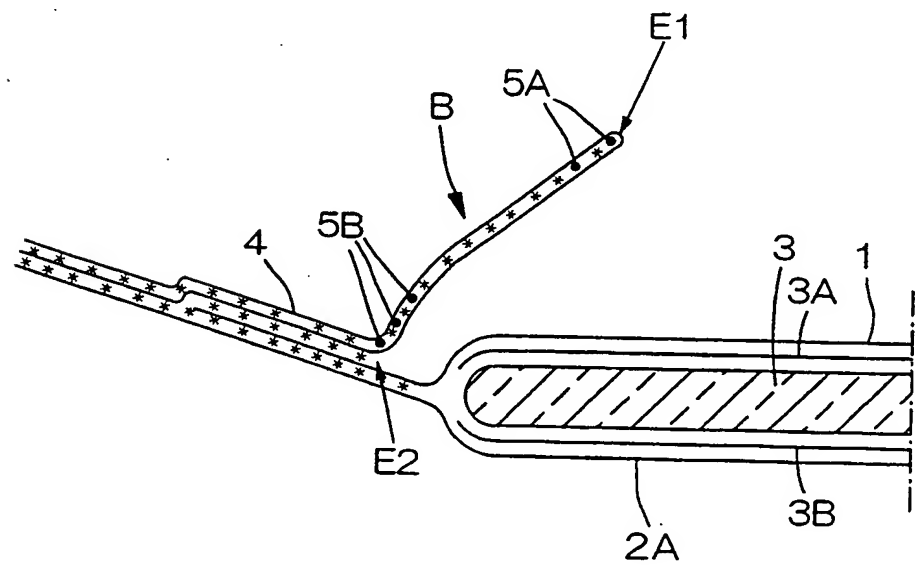


Fig. 6B

~~装着時 WHEN FITTED~~



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~~第7図~~ Fig. 7

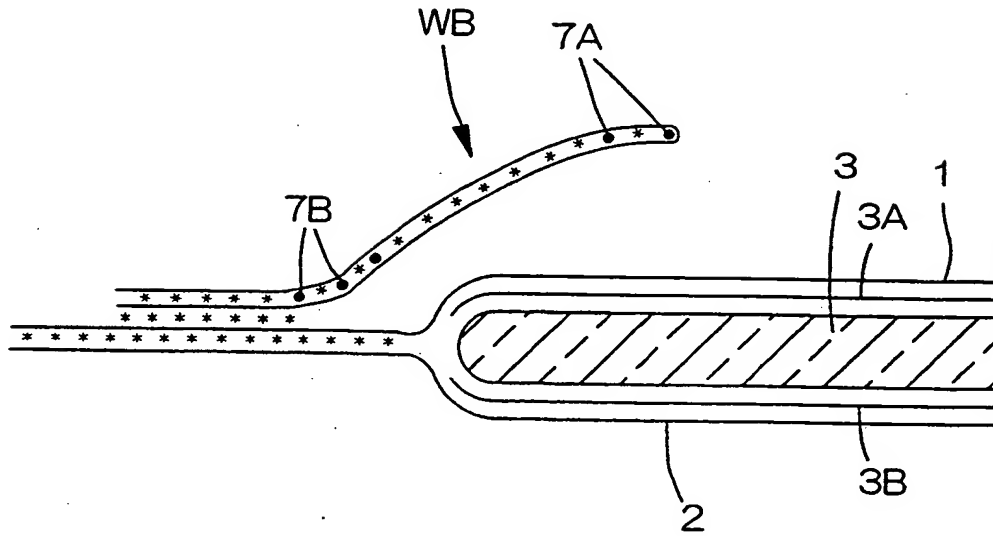




Fig. 8A

—第8圖—

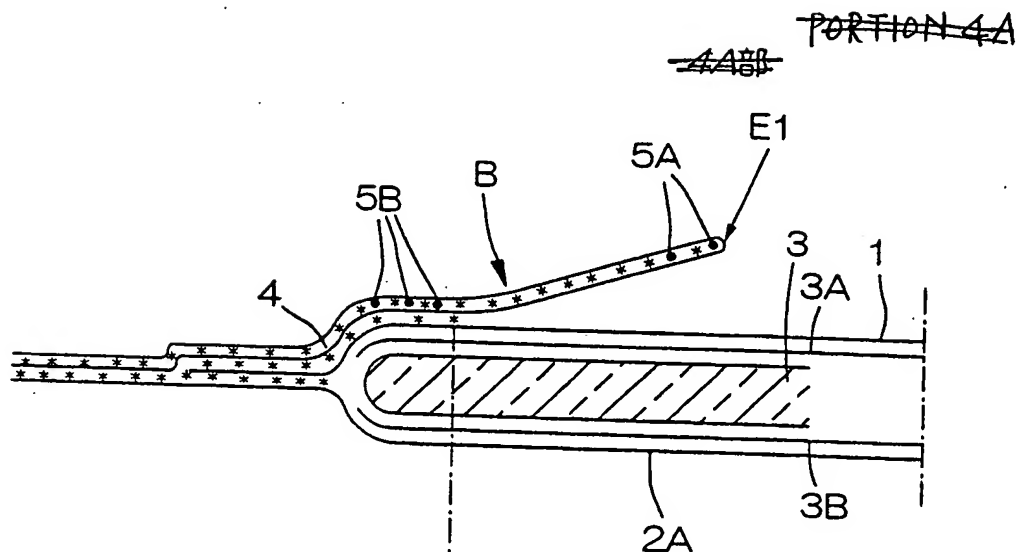
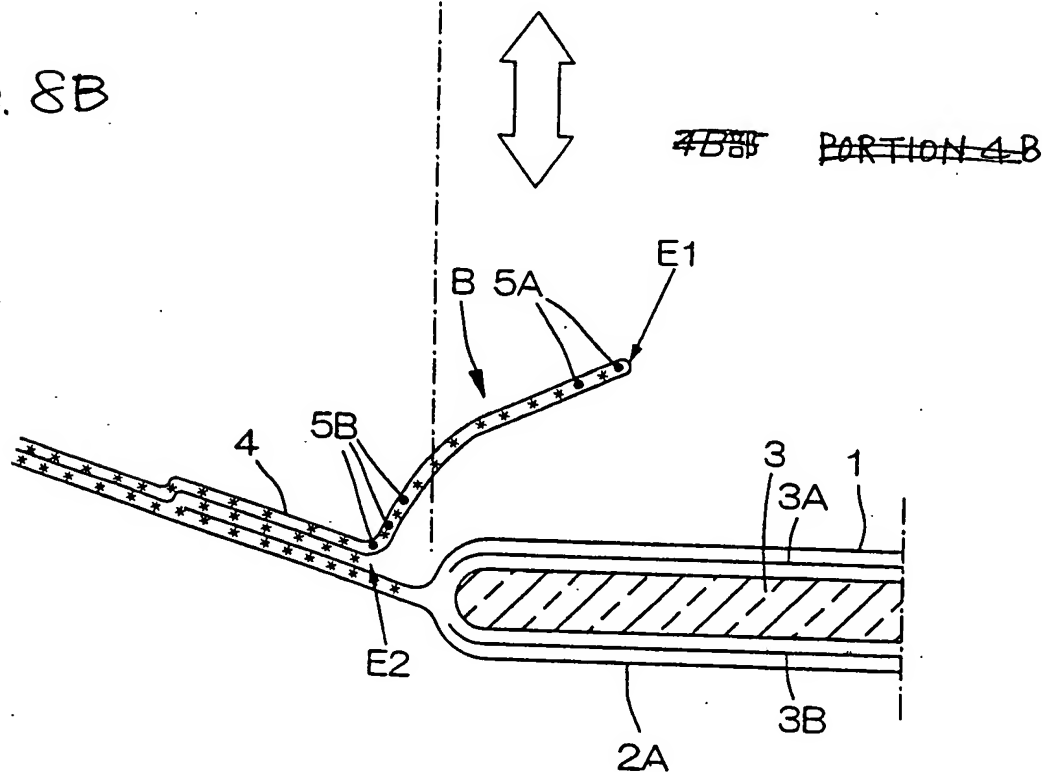


Fig. 8B





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第9図

Fig. 9A

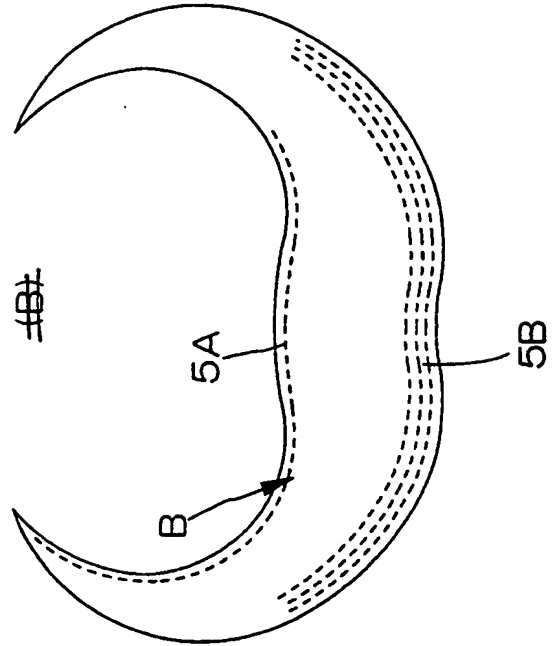
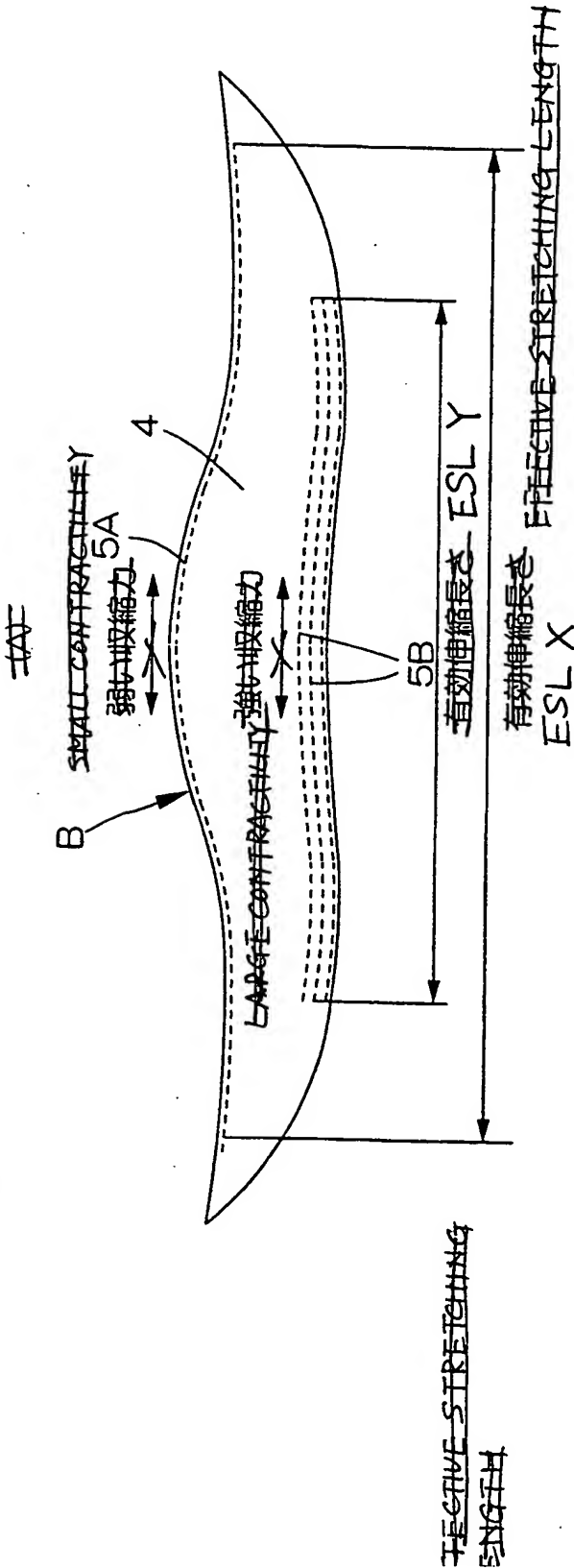
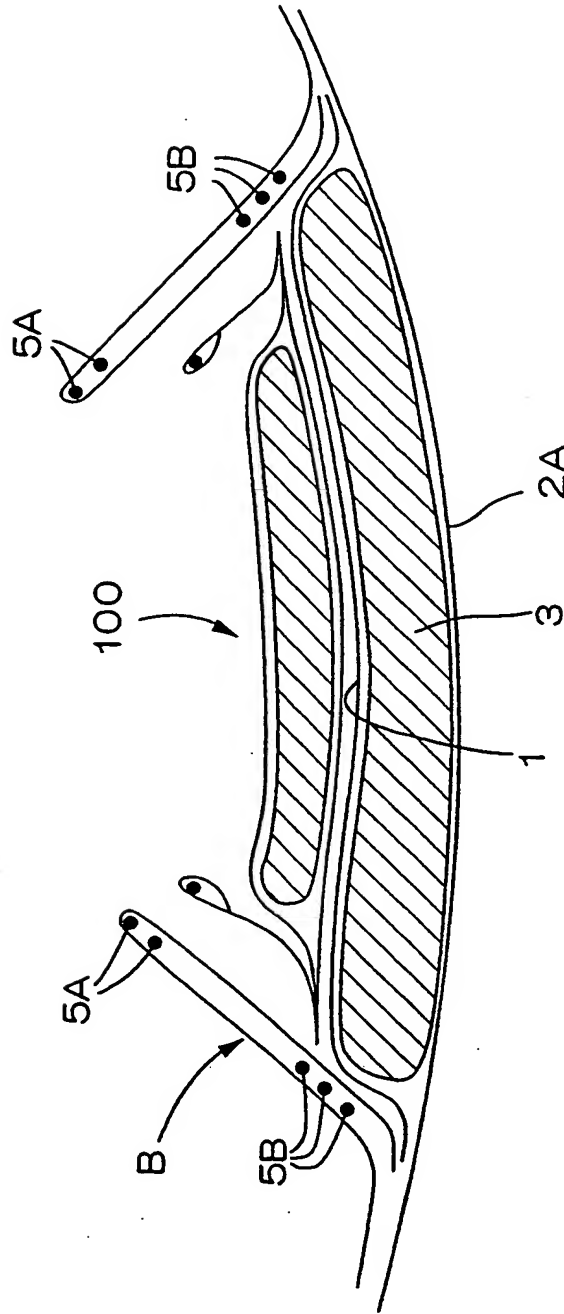


Fig. 9B

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~~第10図~~ Fig. 10





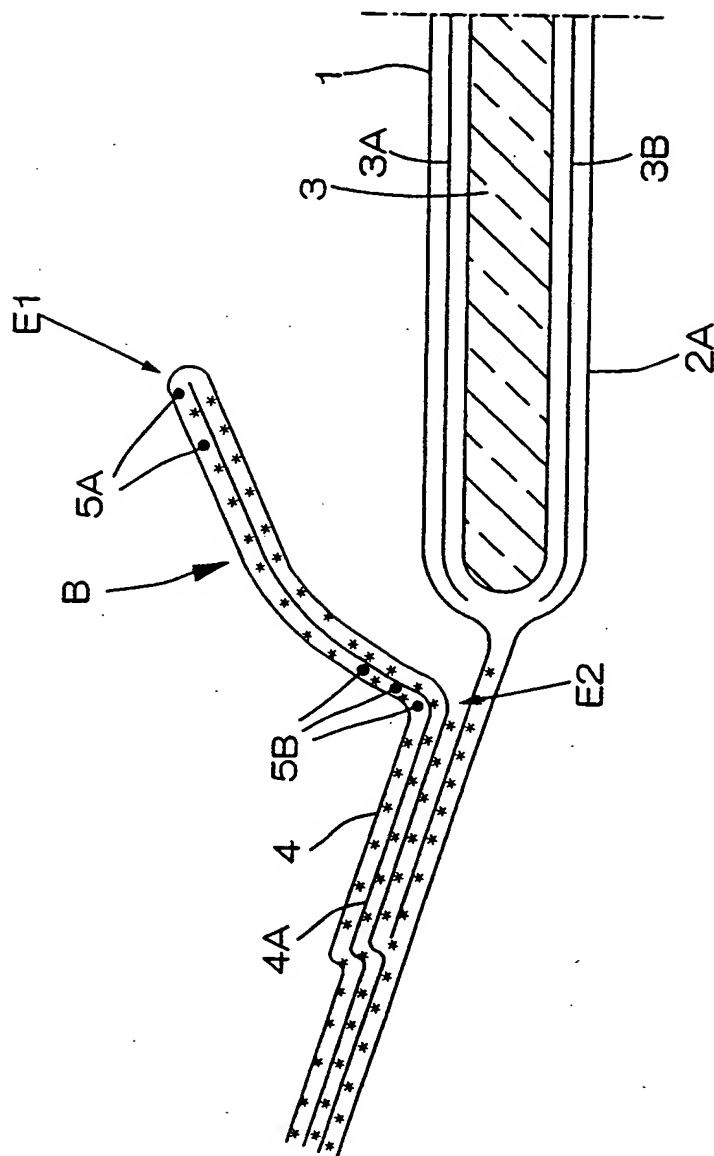
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~~第11図~~ Fig. 11

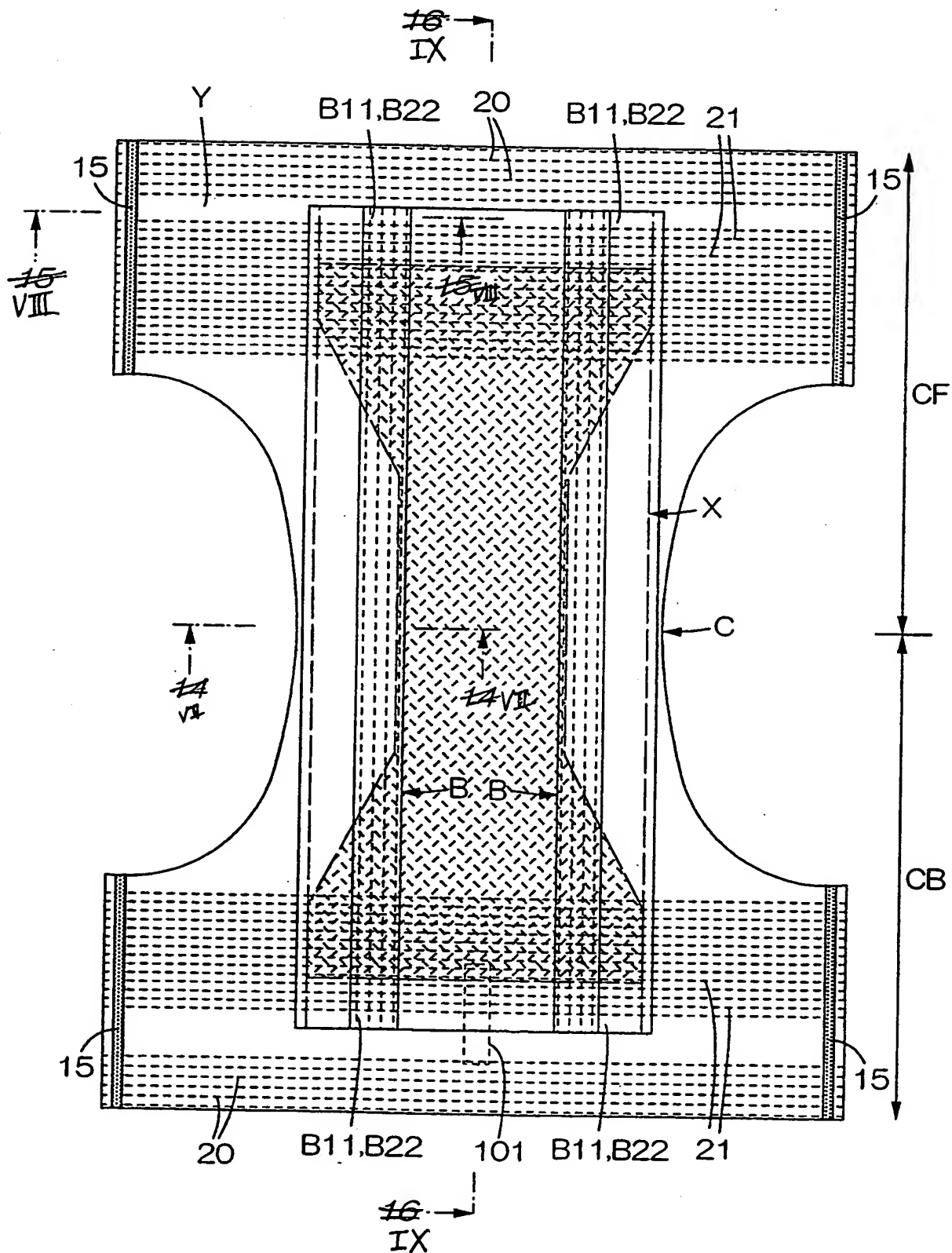






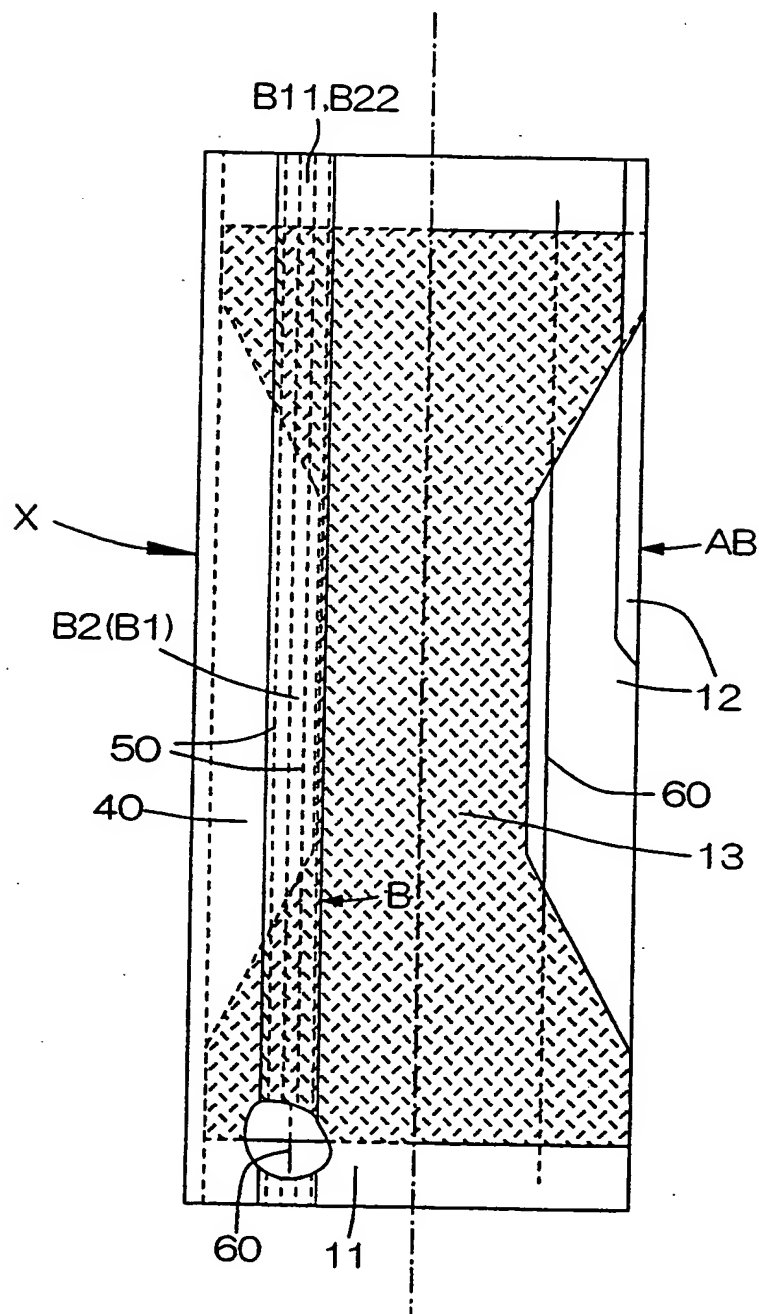
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~~第12圖~~ Fig. 12



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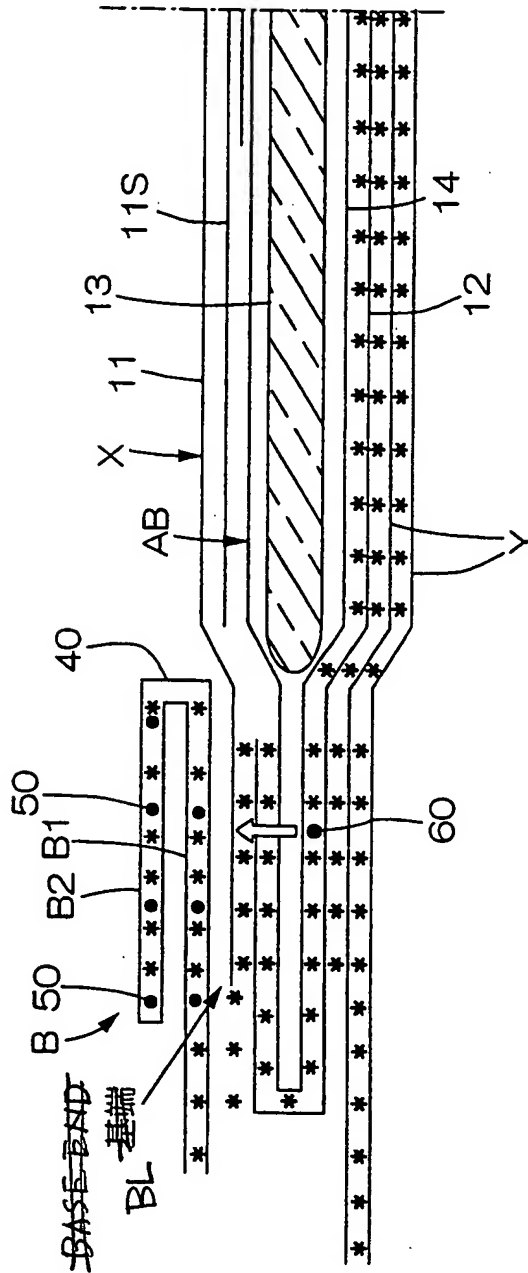
~~第13図~~ Fig. 13



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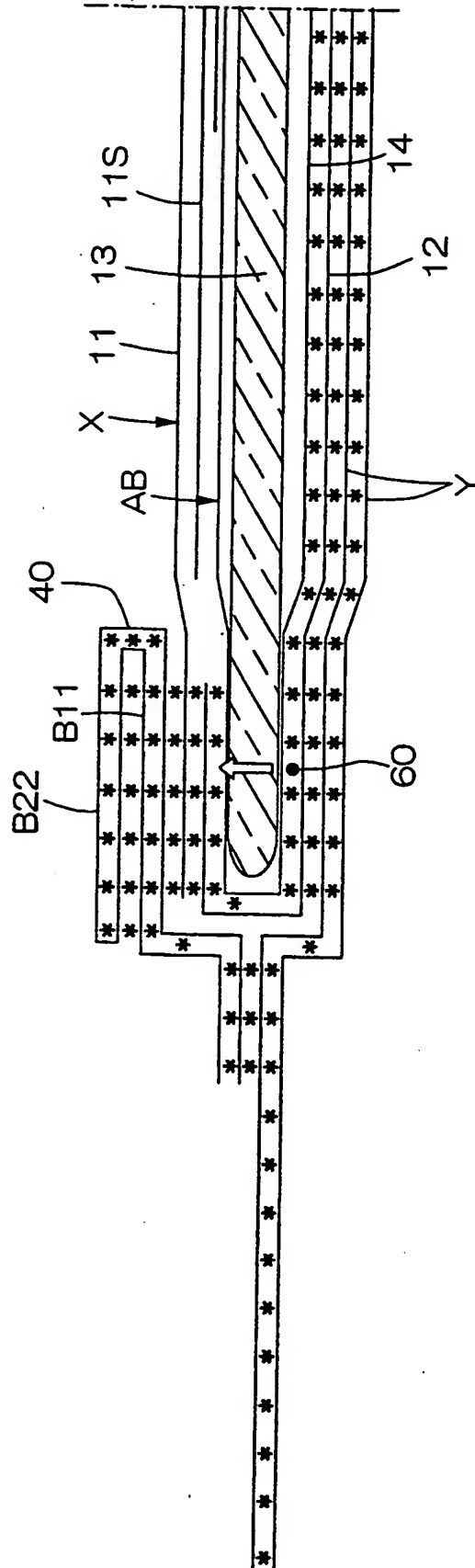


~~第14图~~ Fig. 14





~~第15圖~~ Fig. 15





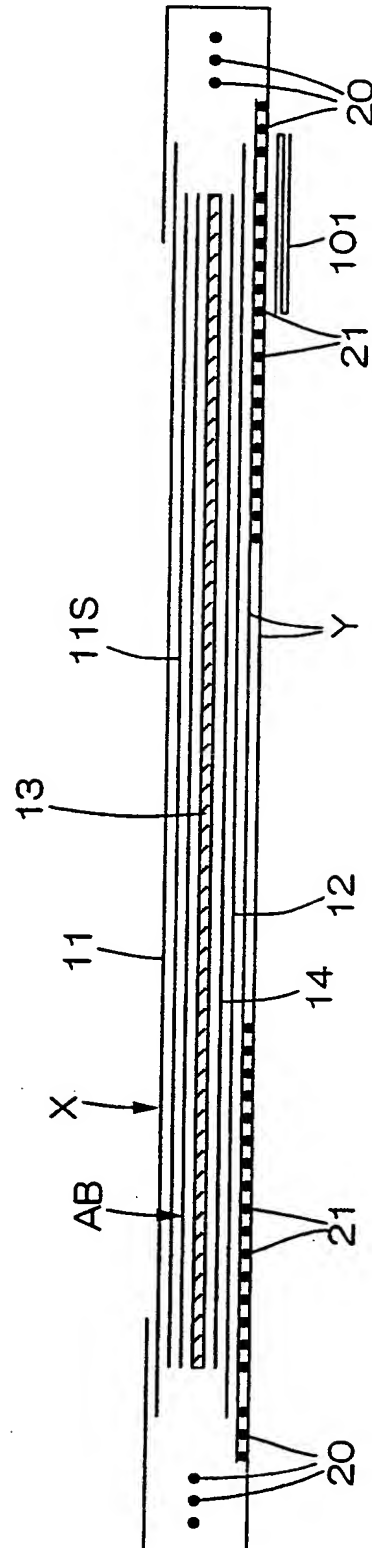
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~~第10圖~~ Fig. 16





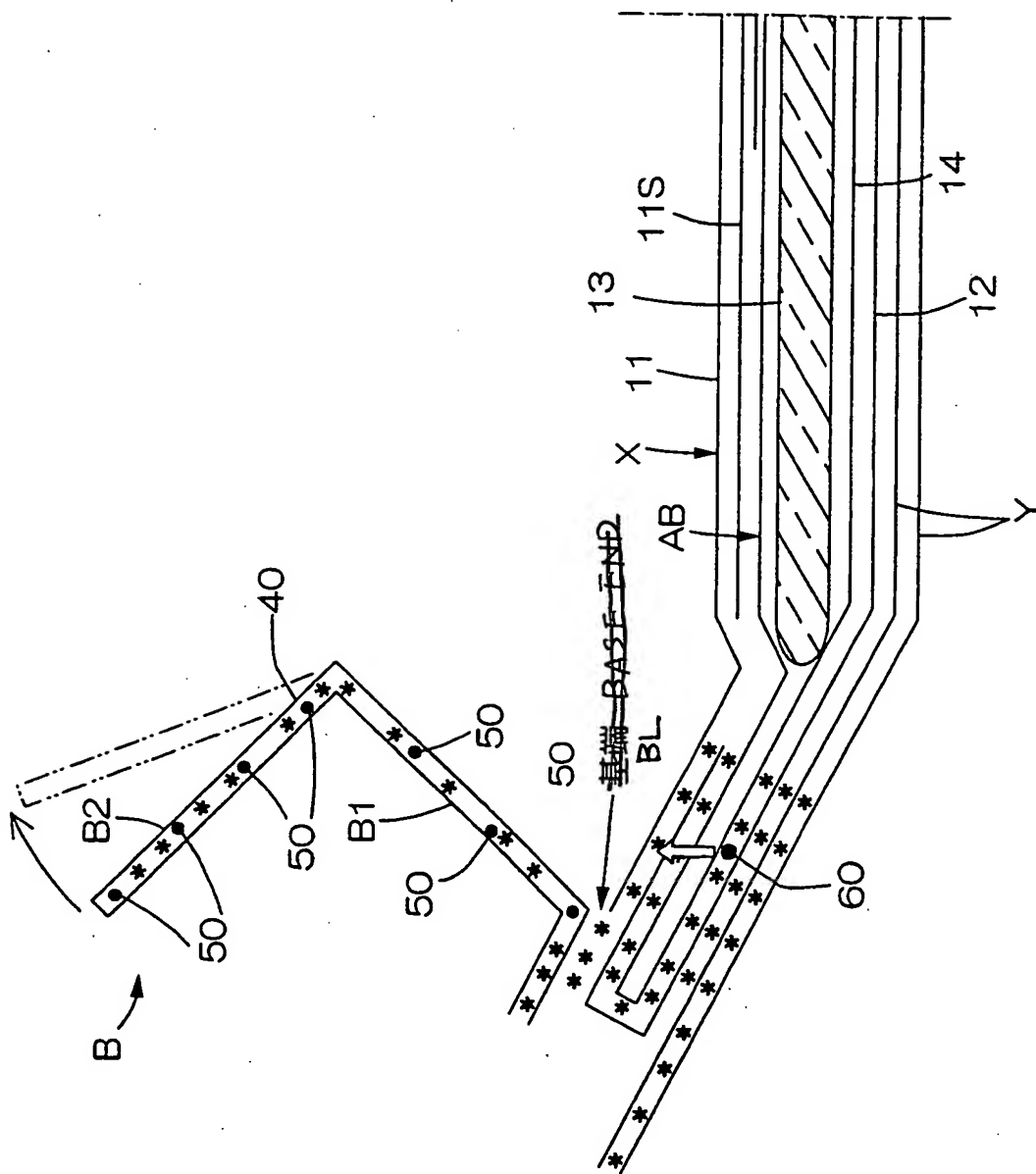
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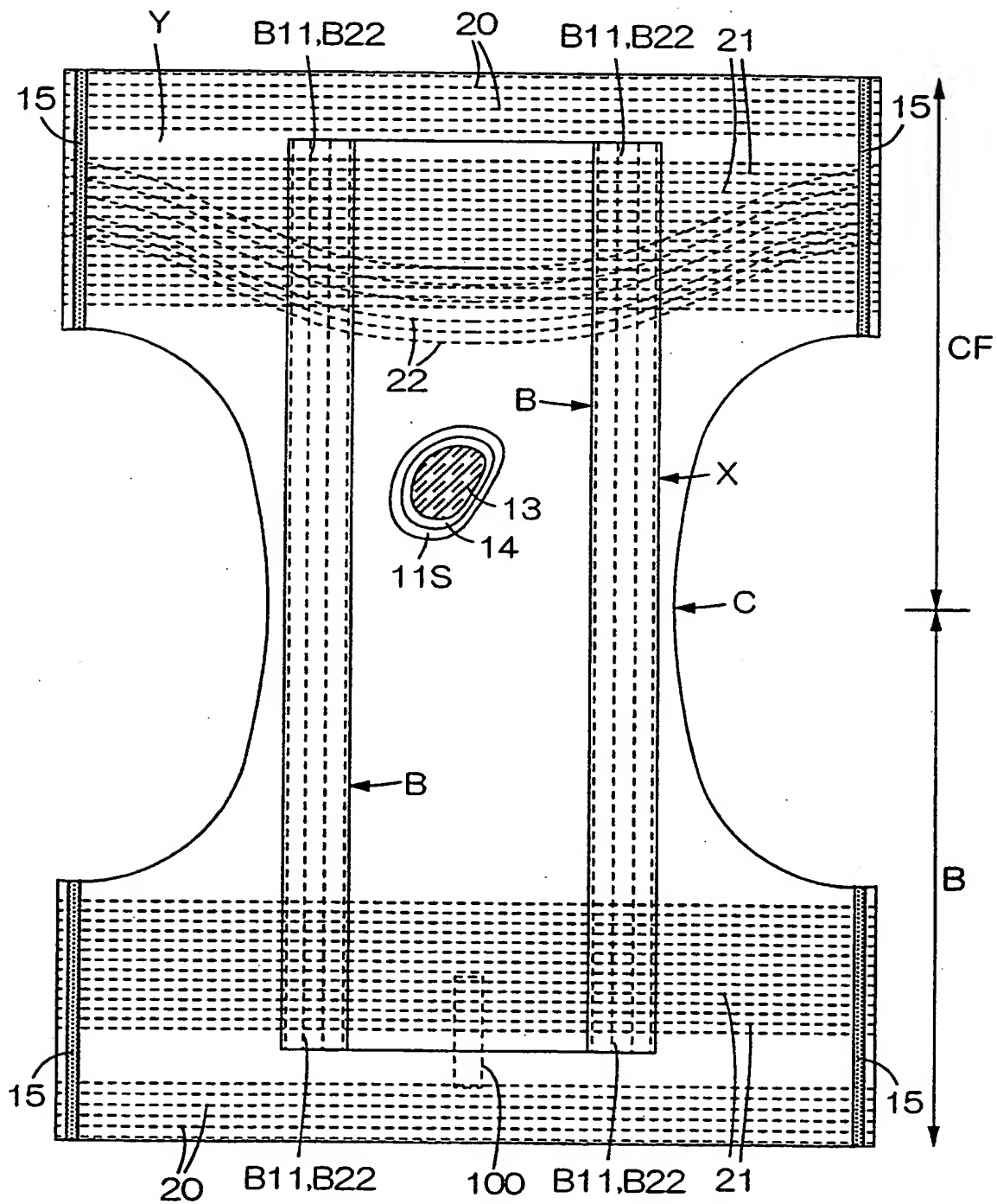
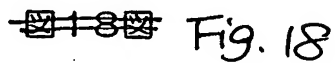
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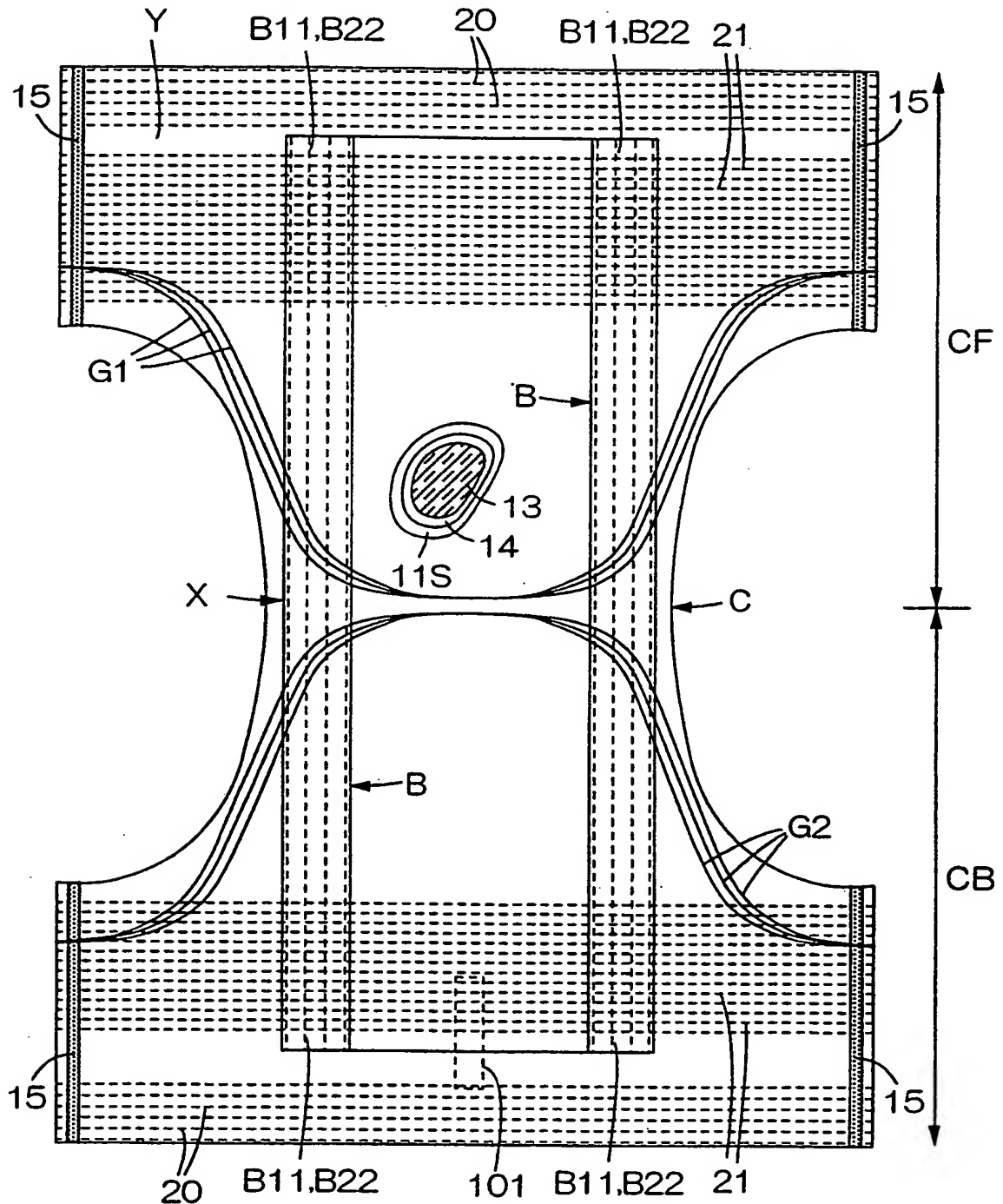
第17圖 Fig. 17





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~~第19圖~~ Fig. 19







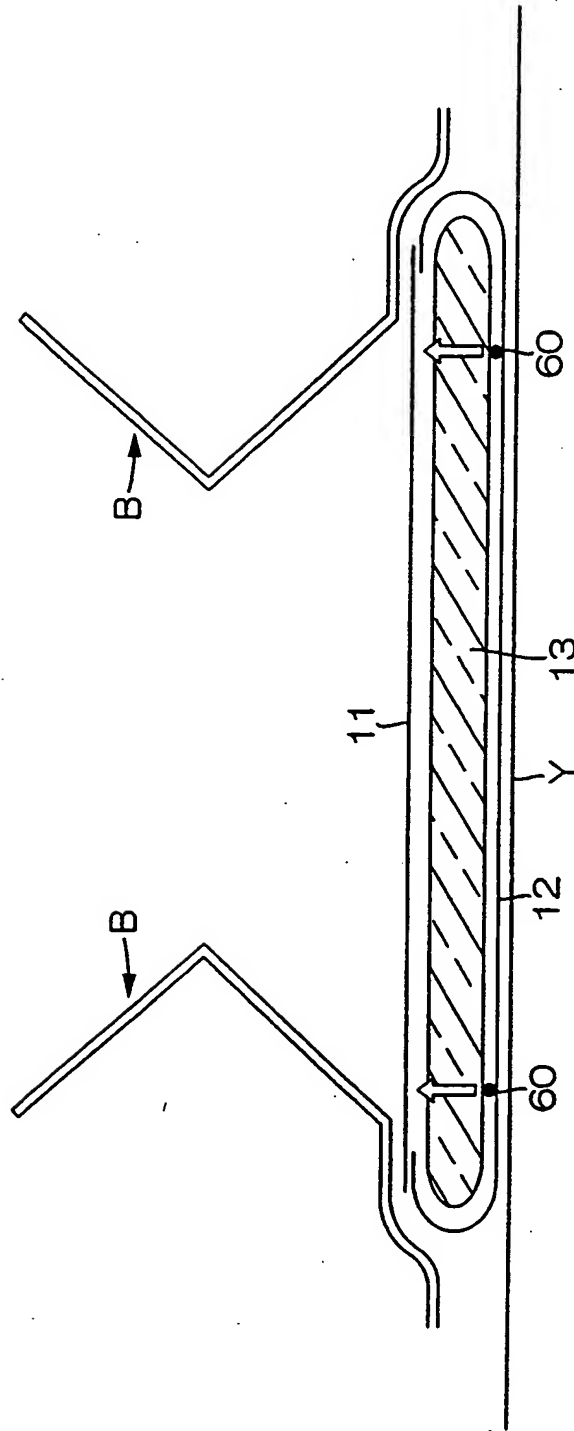
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第20図 Fig. 20

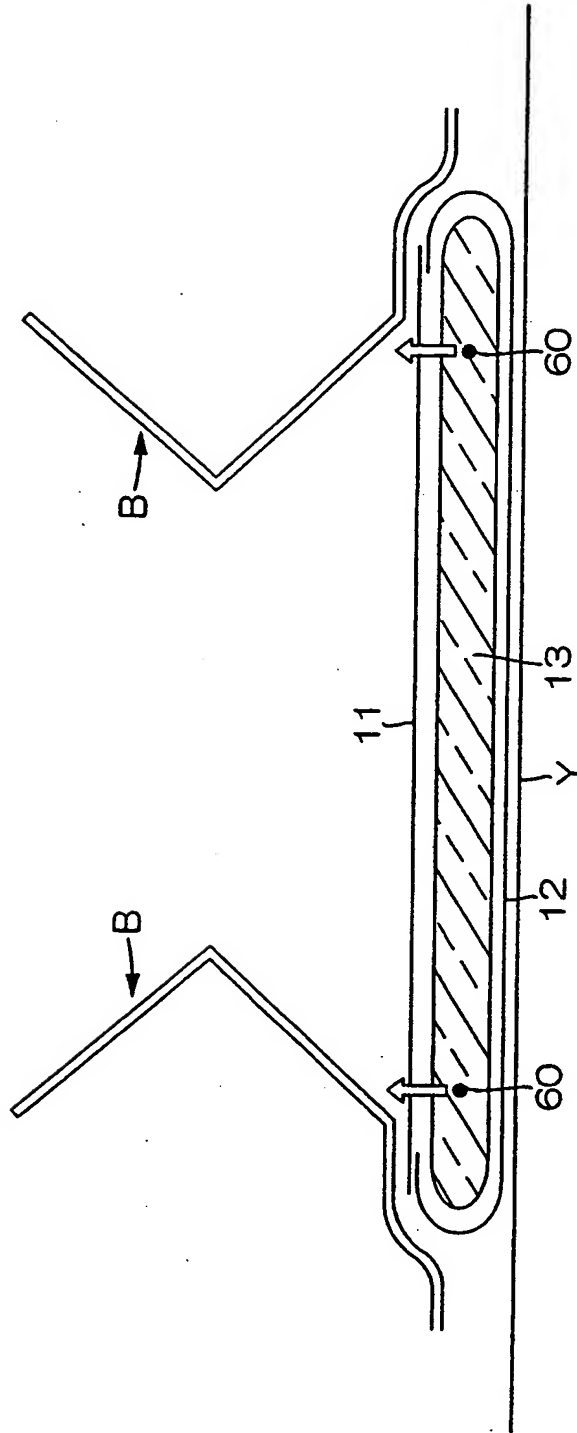


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~~第21圖~~ Fig. 21

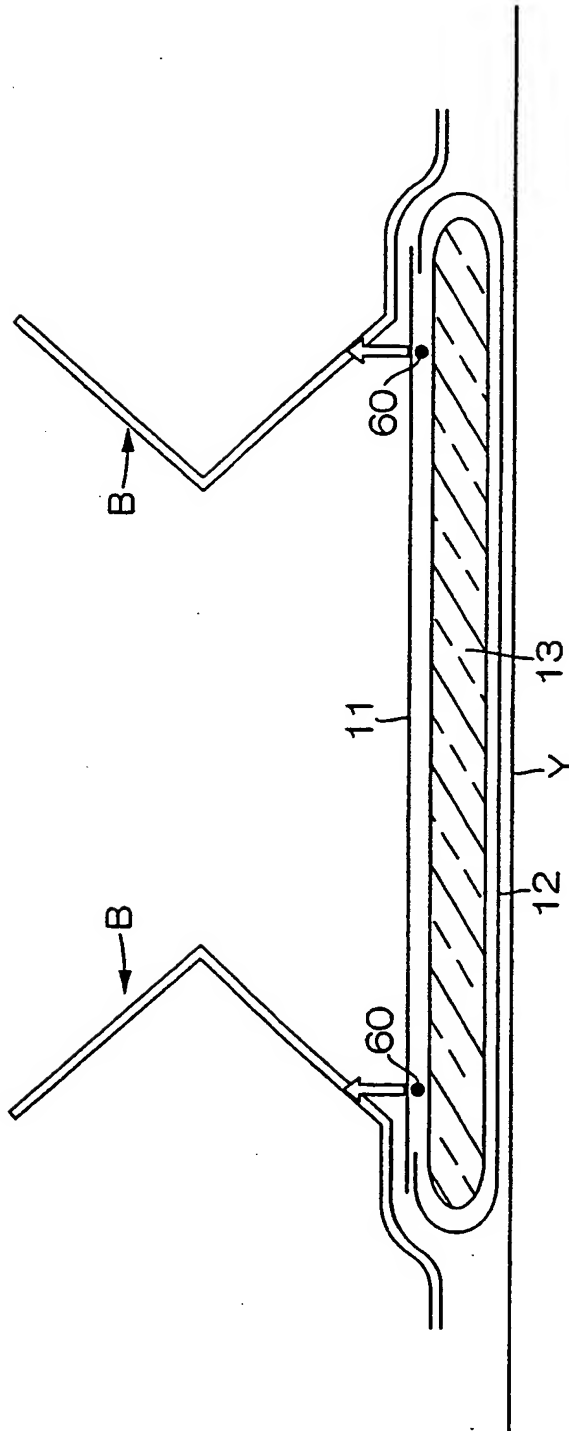




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~~第22圖~~ Fig. 22





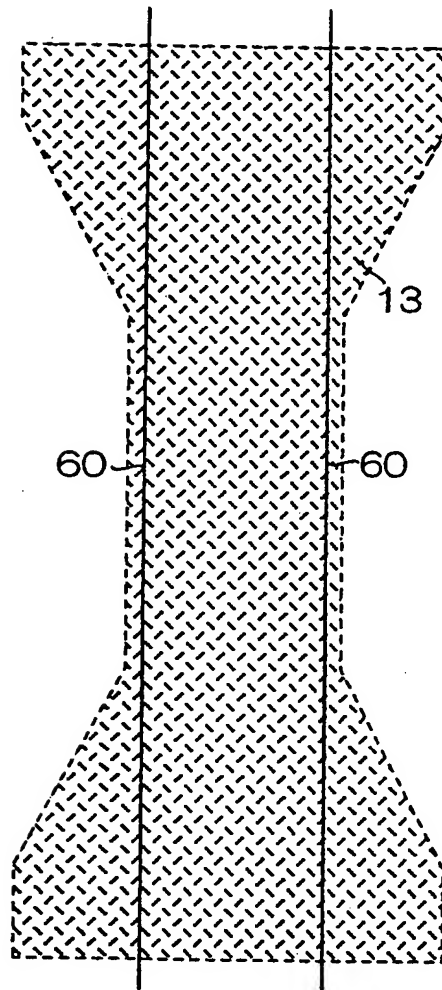
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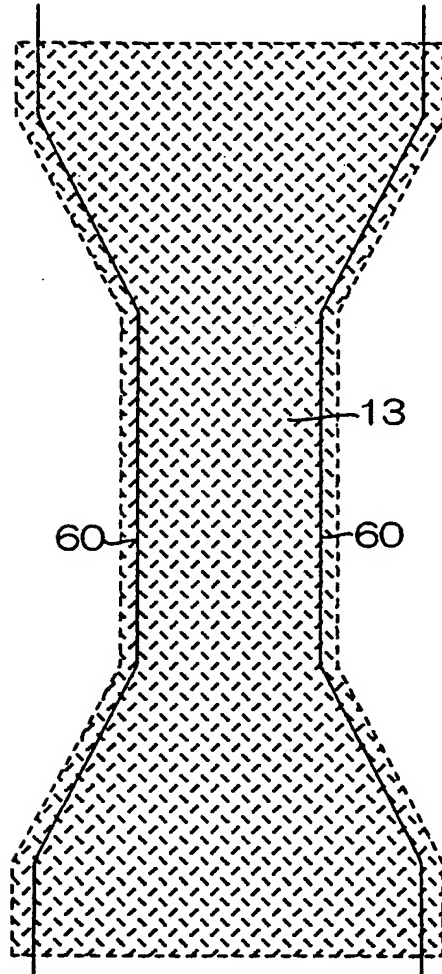
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~~第23圖~~ Fig. 23



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~~第24図~~ Fig. 24





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第25圖 Fig. 25

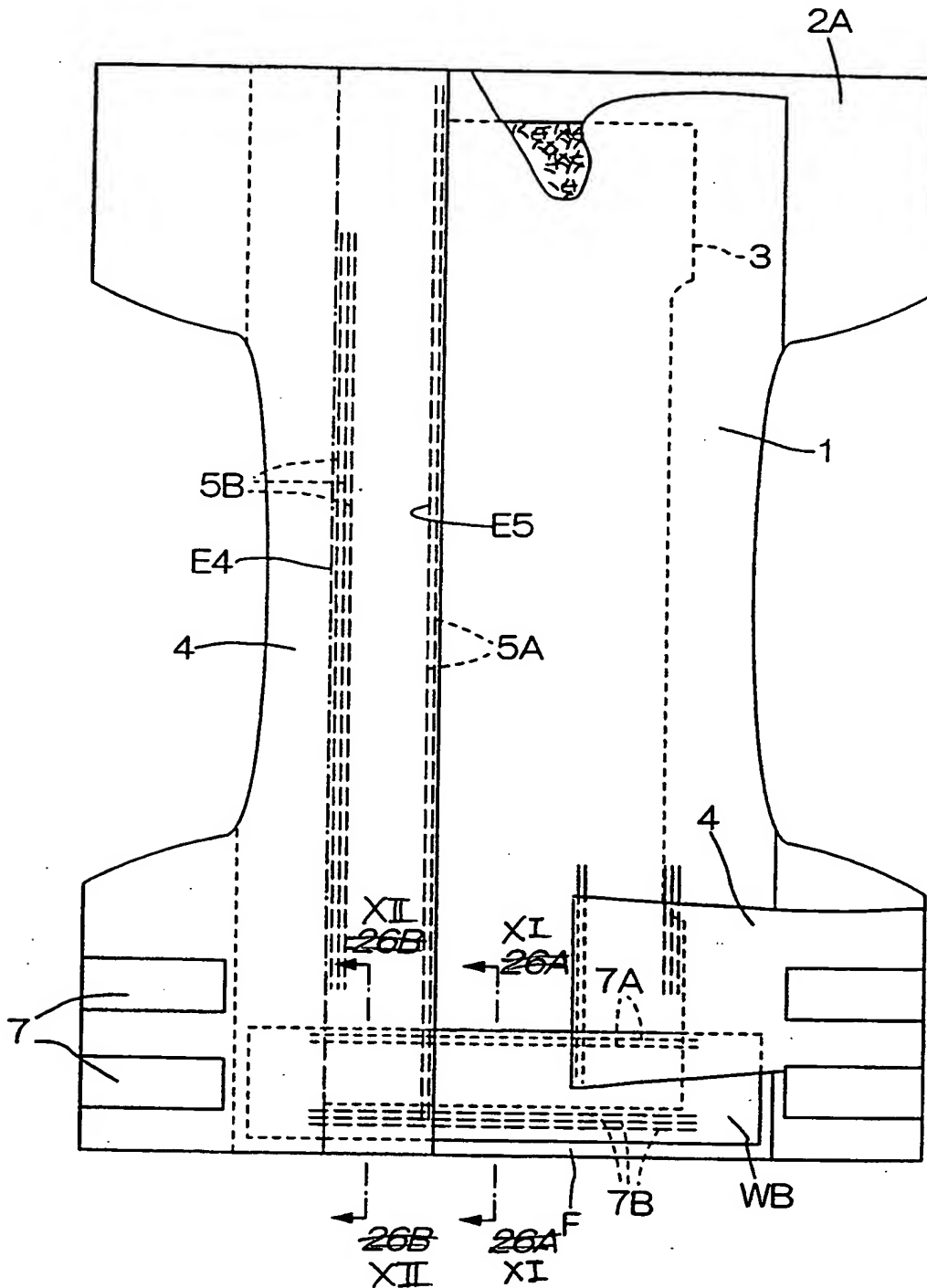




Fig. 26 A

第26圖

~~26B部~~ ~~PORTION 26B~~

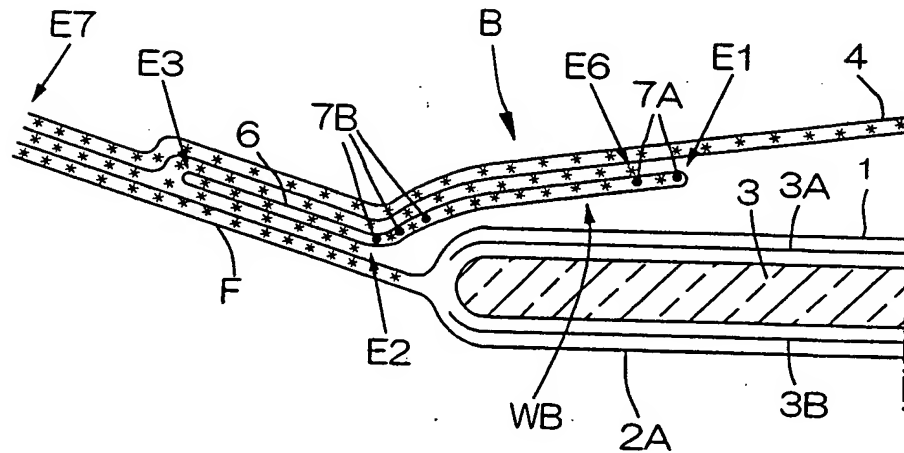
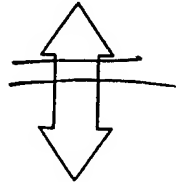
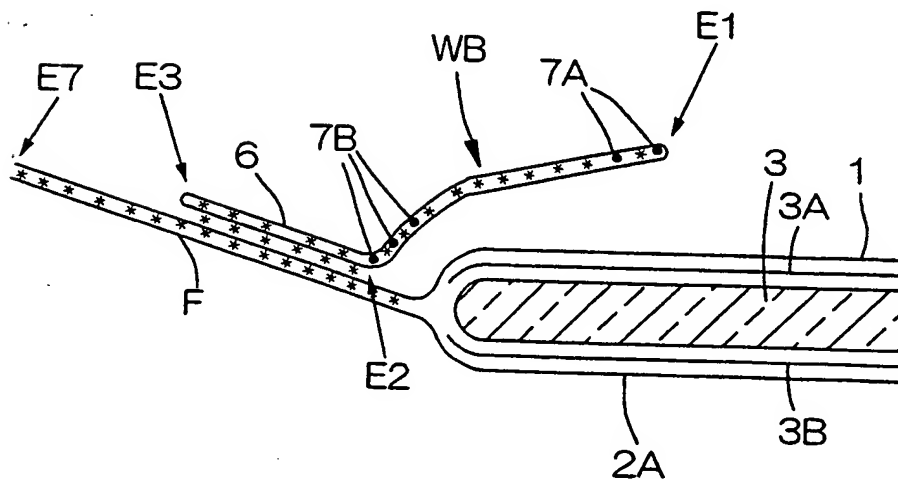


Fig. 26 B



~~26A 部~~ ~~PORTION 26A~~



A detailed schematic diagram of a device cross-section. The diagram shows several horizontal layers and regions. At the top are two rectangular blocks labeled '7'. Below them is a layer labeled 'F' containing regions 'HT' (stippled) and 'HB' (white). Above 'F' is another 'HT' region (stippled), followed by a dashed-line region 'Z'. To the right of 'Z' is a vertical section labeled 'WB' containing layers 'E4' and 'E5'. Further right are layers 'E1', 'E6', 'E2', 'E3', and 'E7'. A dimension 'L' indicates a distance between vertical boundaries. On the left side, there are curved dashed lines labeled '5A' and '5B', and a solid arrow labeled 'B' pointing downwards. A wavy line labeled '4' is also shown.





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第28圖 Fig. 28

